MODEL NAME: Maple

PCB NO: DA8000WL000 LA-B012PR01

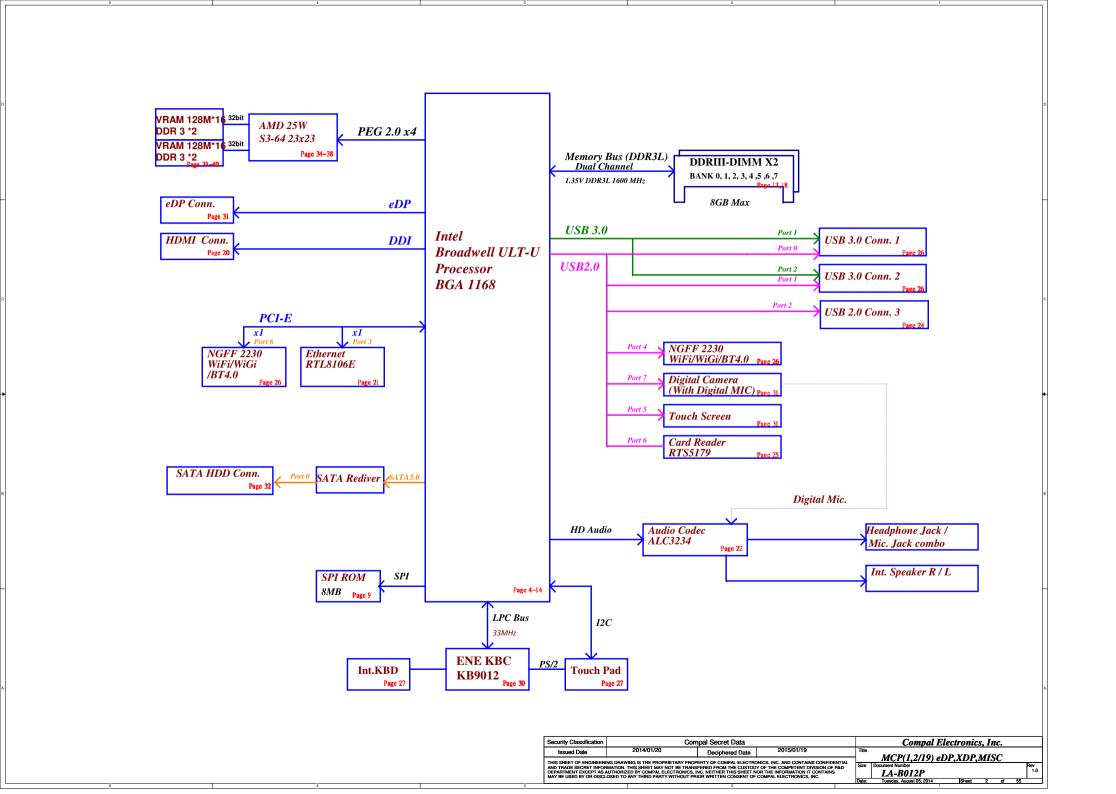
Dell / Compal Confidential

Schematic Document

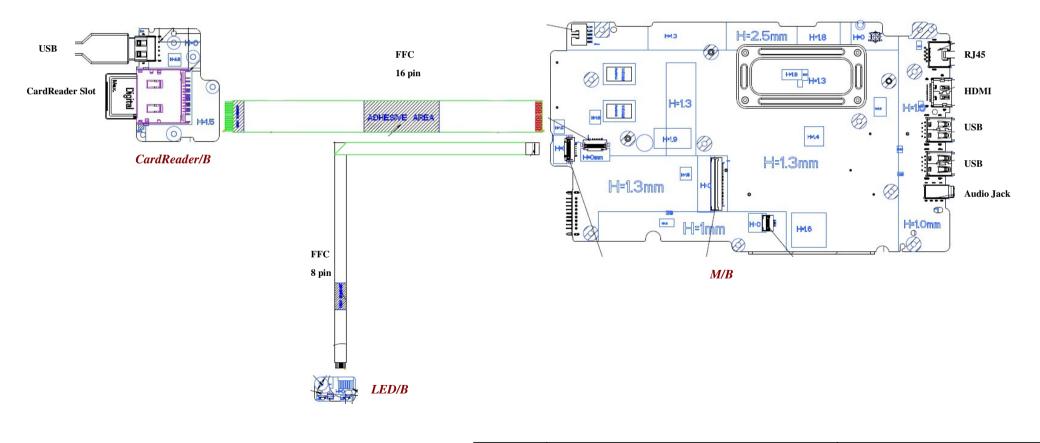
Intel Shark Bay ULT Maple 14"/15" Value UMA / DIS AMD 25W/S3+DDR3x4

2014-01-21 Rev: 1.0

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Board ID Table for AD channel

Vcc	3.3V +/- 1%				
Ra	100K +/- 1%				
Board ID	Rb	V_{AD_BID} min	V _{AD_BID} typ	V _{AD_BID} max	EC AD3
0	0	0.000V	0.000V	0.300V	0x00 - 0x0B
1	12K +/- 1%	0.347V	0.354V	0.360V	0x0C - 0x1C
2	15K +/- 1%	0.423V	0.430V	0.438V	0x1D - 0x26
3	20K +/- 1%	0.541V	0.550V	0.559V	0x27 - 0x30
4	27K +/- 1%	0.691V	0.702V	0.713V	0x31 - 0x3B
5	33K +/- 1%	0.807V	0.819V	0.831V	0x3C - 0x46
6	43K +/- 1%	0.978V	0.992V	1.006V	0x47 - 0x54
7	56K +/- 1%	1.169V	1.185V	1.200V	0x55 - 0x64
8	75K +/- 1%	1.398V	1.414V	1.430V	0x65 - 0x76
9	100K +/- 1%	1.634V	1.650V	1.667V	0x77 - 0x87
10	130K +/- 1%	1.849V	1.865V	1.881V	0x88 - 0x96
11	160K +/- 1%	2.015V	2.031V	2.046V	0x97 - 0xA3
12	200K +/- 1%	2.185V	2.200V	2.215V	0xA4 - 0xAD
13	240K +/- 1%	2.316V	2.329V	2.343V	0xAE - 0xB7
14	270K +/- 1%	2.395V	2.408V	2.421V	0xB8 - 0xC0
15	330K +/- 1%	2.521V	2.533V	2.544V	0xC1 - 0xC9
16	430K +/- 1%	2.667V	2.677V	2.687V	0xCA - 0xD3
17	560K +/- 1%	2.791V	2.800V	2.808V	0xD4 - 0xDC
18	750K +/- 1%	2.905V	2.912V	2.919V	0xDD - 0xE6
19	NC	3.000V	3.300V	3.300V	0xE7 - 0xFF

SMBUS Control Table

DIADOD CONCIOI I									
	SOURCE	BATT	Charger	VGA	DIMM	XDP	Thermal Sensor	FFS	
EC_SMB_CK1 EC_SMB_DA1	КВ9012	V	V						
EC_SMB_CK2 EC_SMB_DA2	KB9012			V			V		<
SMBCLK SMBDATA	ULT				V	V		V	
SMLOCLK SMLODATA	ULT								
SML1CLK SML1DATA	ULT								₹

HSW BOARD ID Table

Board ID	UMA	DIS (JET)	DIS (Topa
0	SSI		
1		SSI	
2			SSI
3	PT		
4		PT	
5			PT
6	ST		
7		ST	
8			ST
9	1.0		
10		1.0	
11			1.0

BDW BOARD ID Table

Board ID	UMA	DIS (JET)	DIS (Topa
		DIS (UEI)	DIS (TOPE
0	Pre-SSI		
1		Pre-SSI	
2			Pre-SSI
3	SSI		
4		SSI	
5			SSI
6	PT		
7		PT	
8			PT
9	ST		
10		ST	
11			ST
12	1.0		
13		1.0	
14			1.0

Symbol Note:



: means Analog Ground

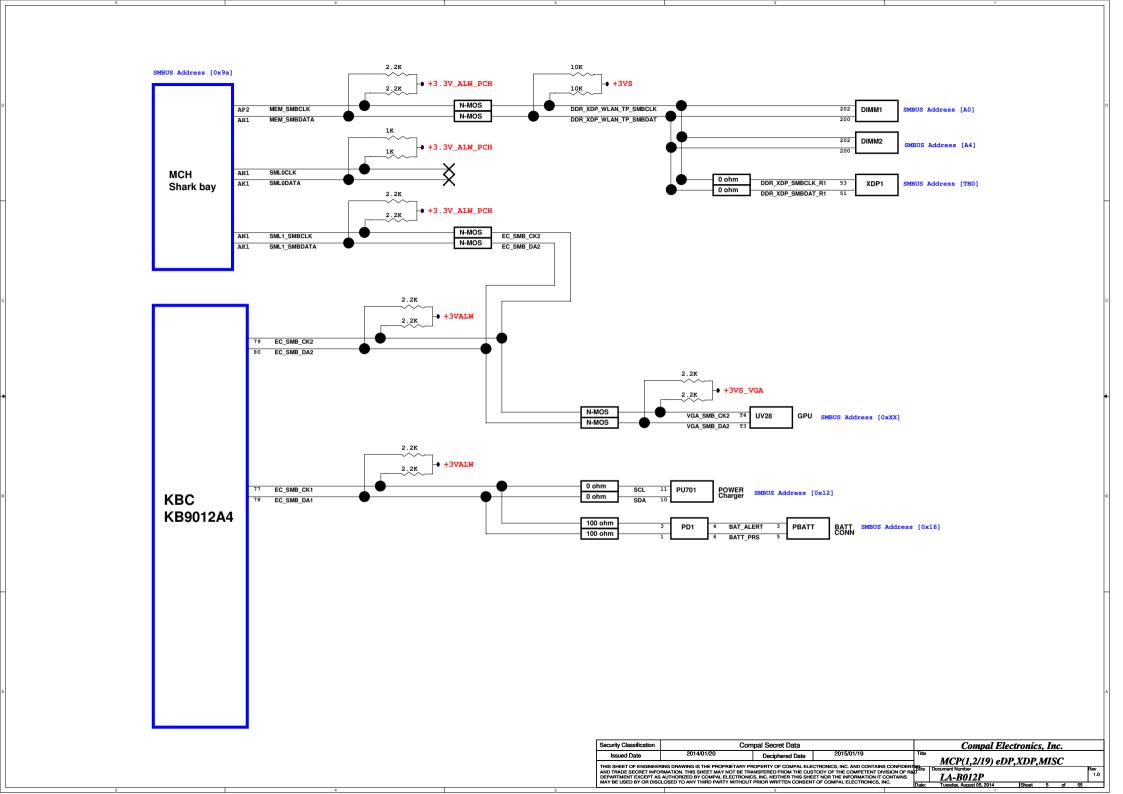
CLOCK SIGNAL						
CLKOUT_PCIE0						
CLKOUT_PCIE1						
CLKOUT_PCIE2	10/100 LAN					
CLKOUT_PCIE3	MINI Card (WLAN)					
CLKOUT_PCIE4	dGPU					
CLKOUT_PCIE5						

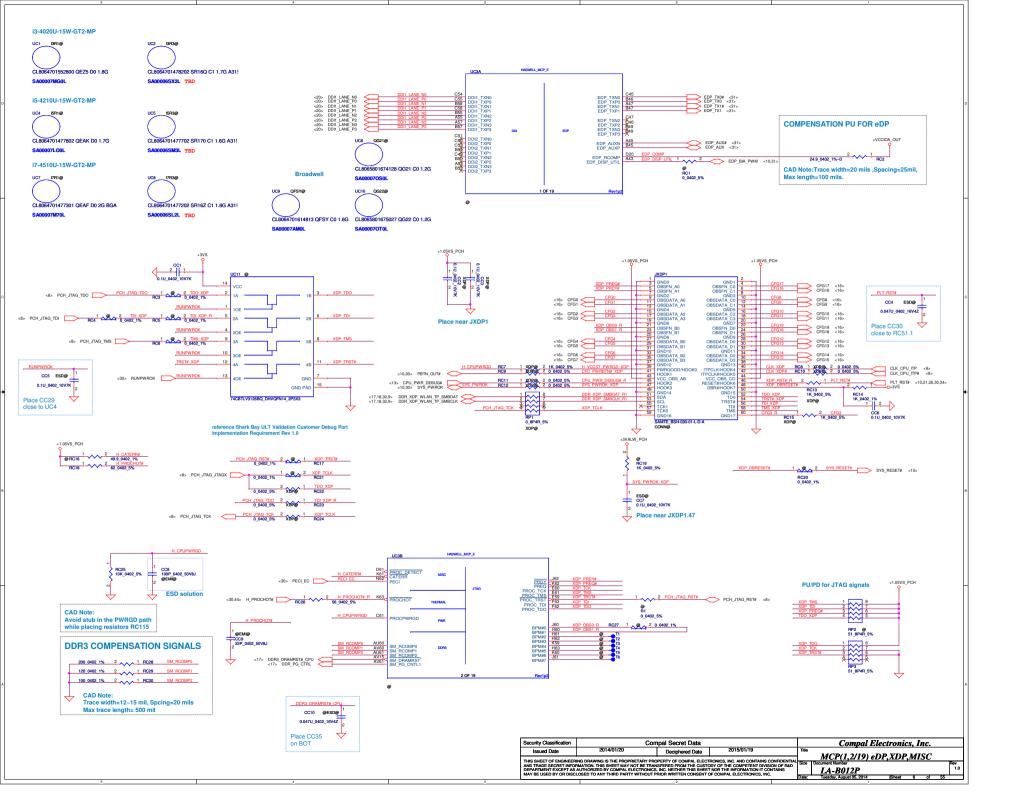
Link

Port1 USB connector 1 Port2 USB connector 2 Port3 Port4 USB2.0 Port0 USB connector 1 Port1 USB connector 2 Port2 USB connector 3 (D/B) Port3 Port4 MINI Card (WLAN) Port5 Touch Screen Panel Port7 Camera PCI EXPRESS Lane 1 Lane 2 Lane 3 10/100 LAN Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1 SATA2			USB3.0			
Port3 Port4 USB2.0 Port0 USB connector 1 Port1 USB connector 2 Port2 USB connector 3 (D/B) Port3 Port4 MINI Card (WLAN) Port5 Touch Screen Panel Port6 Card Reader Port7 Camera PCI EXPRESS Lane 1 Lane 2 Lane 3 10/100 LAN Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1		Port1	USB connector 1			
Port4 USB2.0 Port0 USB connector 1 Port1 USB connector 2 Port2 USB connector 3 (D/B) Port3 Port4 MINI Card (WLAN) Port5 Touch Screen Panel Port6 Card Reader Port7 Camera PCI EXPRESS Lane 1 Lane 2 Lane 3 10/100 LAN Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1		Port2	USB connector 2			
USB2.0 Port0 USB connector 1 Port1 USB connector 2 Port2 USB connector 3 (D/B) Port3 Port4 MINI Card (WLAN) Port5 Touch Screen Panel Port6 Card Reader Port7 Camera PCI EXPRESS Lane 1 Lane 2 Lane 3 10/100 LAN Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1		Port3				
Port0 USB connector 1 Port1 USB connector 2 Port2 USB connector 3 (D/B) Port3 Port4 MINI Card (WLAN) Port5 Touch Screen Panel Port6 Card Reader Port7 Camera PCI EXPRESS Lane 1 Lane 2 Lane 3 10/100 LAN Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1		Port4				
Port1 USB connector 2 Port2 USB connector 3 (D/B) Port3 Port4 MINI Card (WLAN) Port5 Touch Screen Panel Port6 Card Reader Port7 Camera PCI EXPRESS Lane 1 Lane 2 Lane 3 10/100 LAN Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1			USB2.0			
Port2 USB connector 3 (D/B) Port3 Port4 MINI Card (WLAN) Port5 Touch Screen Panel Port6 Card Reader Port7 Camera PCI EXPRESS Lane 1 Lane 2 Lane 3 10/100 LAN Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1		Port0	USB connector 1			
Port3 Port4 MINI Card (WLAN) Port5 Touch Screen Panel Port6 Card Reader Port7 Camera PCI EXPRESS Lane 1 Lane 2 Lane 3 10/100 LAN Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1		Port1	USB connector 2			
Port4 MINI Card (WLAN) Port5 Touch Screen Panel Port6 Card Reader Port7 Camera PCI EXPRESS Lane 1 Lane 2 Lane 3 10/100 LAN Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1		Port2	USB connector 3 (D/B)			
Port5 Touch Screen Panel Port6 Card Reader Port7 Camera PCI EXPRESS Lane 1 Lane 2 Lane 3 10/100 LAN Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1		Port3				
Port6 Card Reader		Port4	MINI Card (WLAN)			
Port7 Camera PCI EXPRESS Lane 1 Lane 2 Lane 3 10/100 LAN Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1		Port5	Touch Screen Panel			
PCI EXPRESS Lane 1 Lane 2 Lane 3 10/100 LAN Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1	ULT	Port6	Card Reader			
Lane 1 Lane 2 Lane 3 10/100 LAN Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1		Port7	Camera			
Lane 2 Lane 3 10/100 LAN Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1		PCI EXPRESS				
Lane 3 10/100 LAN Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1		Lane 1				
Lane 4 MINI Card (WLAN) Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1		Lane 2				
Lane 5 PEG (AMD JET/TOBAZ) Lane 6 SATA SATA0 HDD SATA1		Lane 3	10/100 LAN			
SATA SATA0 HDD SATA1		Lane 4	MINI Card (WLAN)			
SATA SATA0 HDD SATA1		Lane 5	PEG (AMD JET/TOBAZ)			
SATA0 HDD SATA1		Lane 6				
SATA1			SATA			
		SATA0	HDD			
SATA2		SATA1				
		SATA2				
SATA3		SATA3				

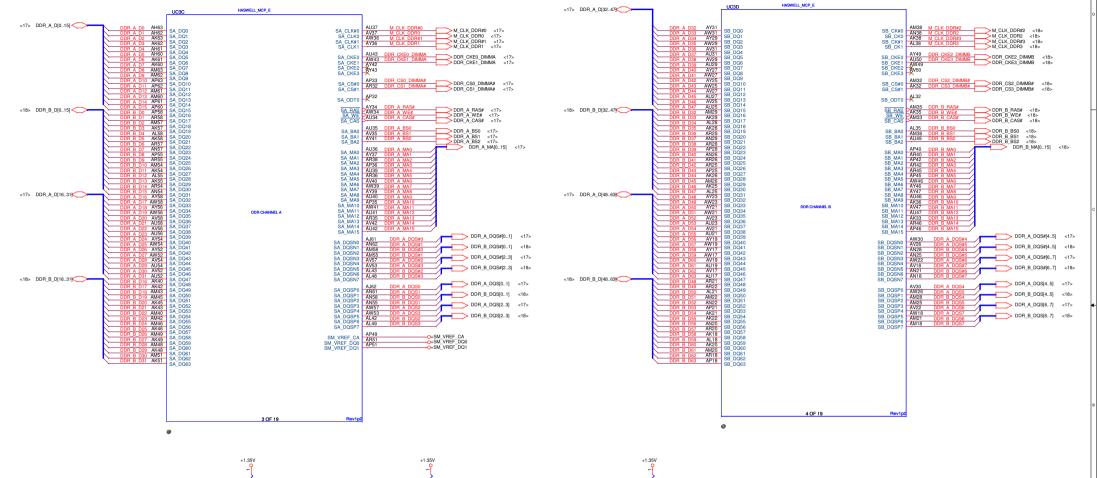
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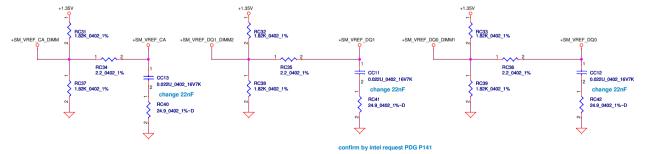
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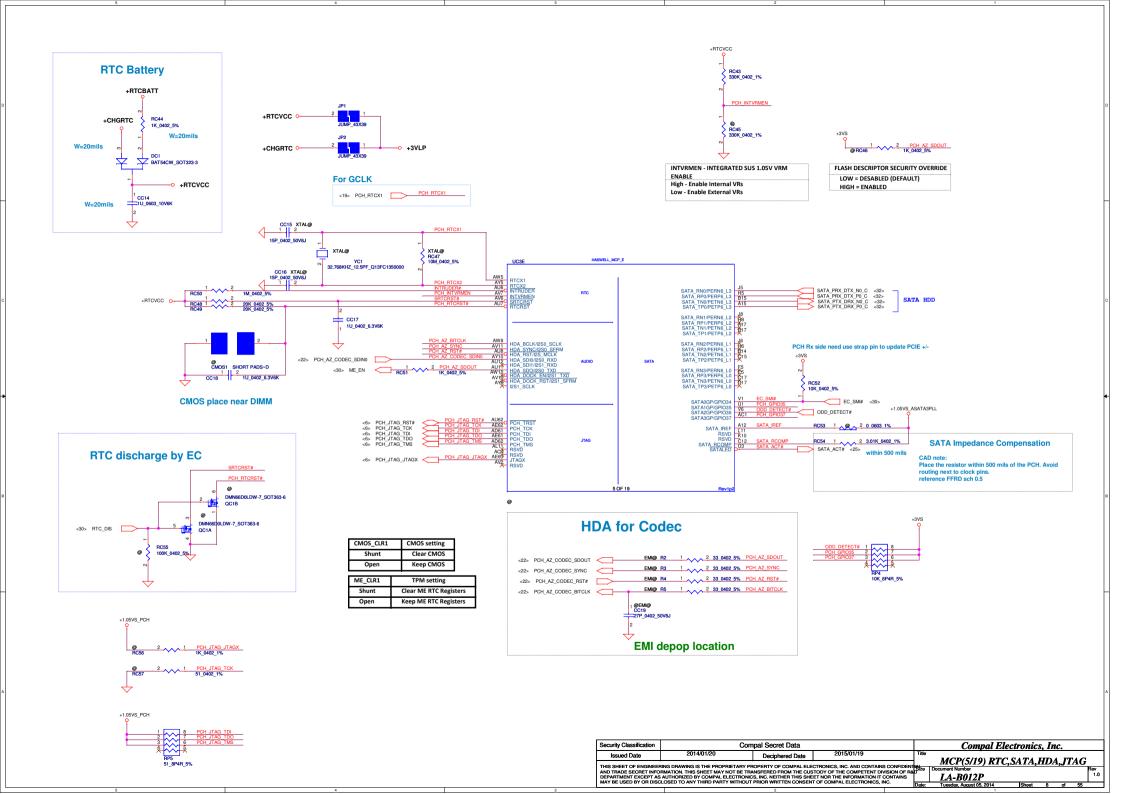


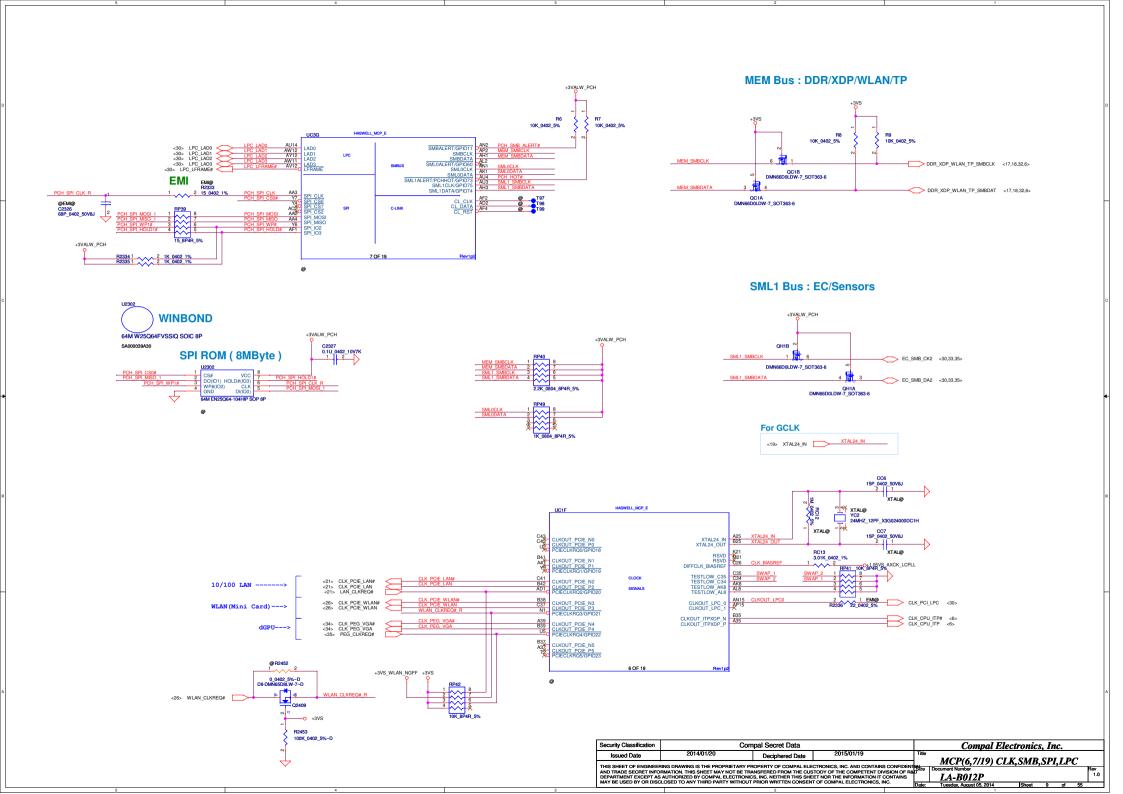
Interleaved Memory

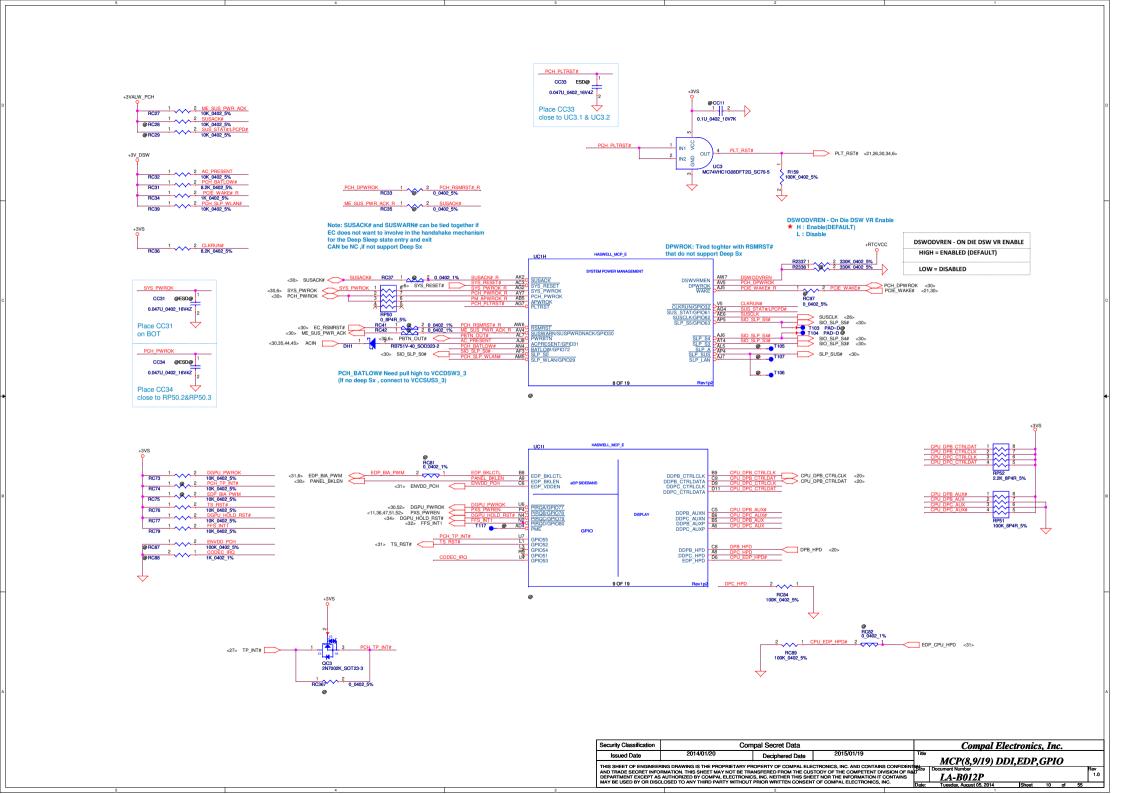


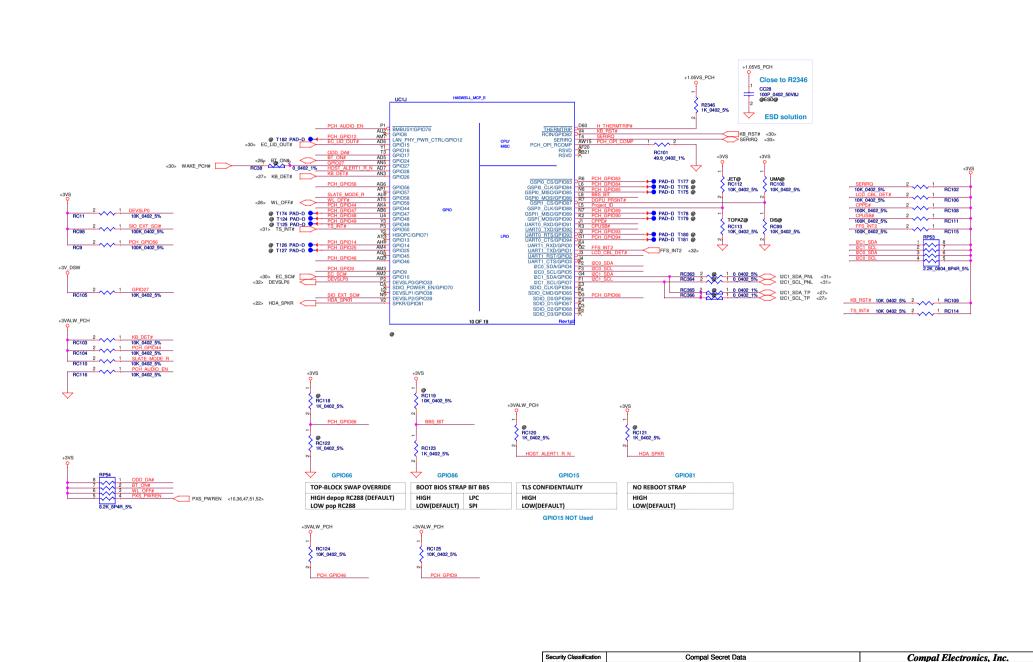


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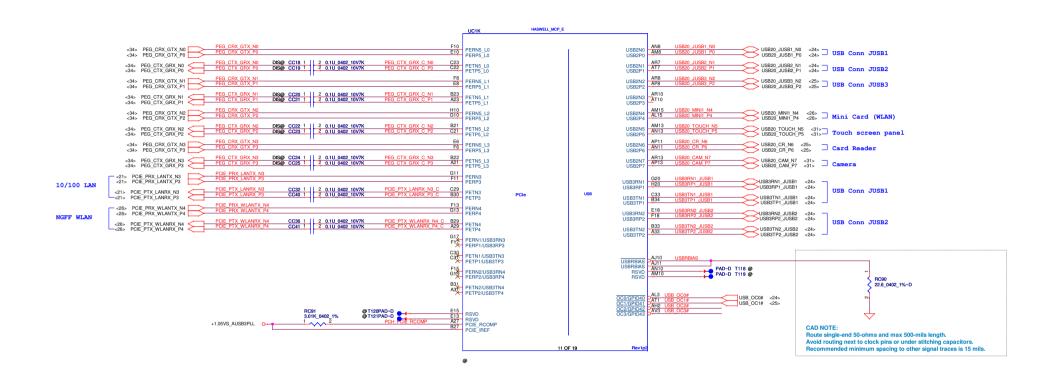


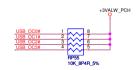


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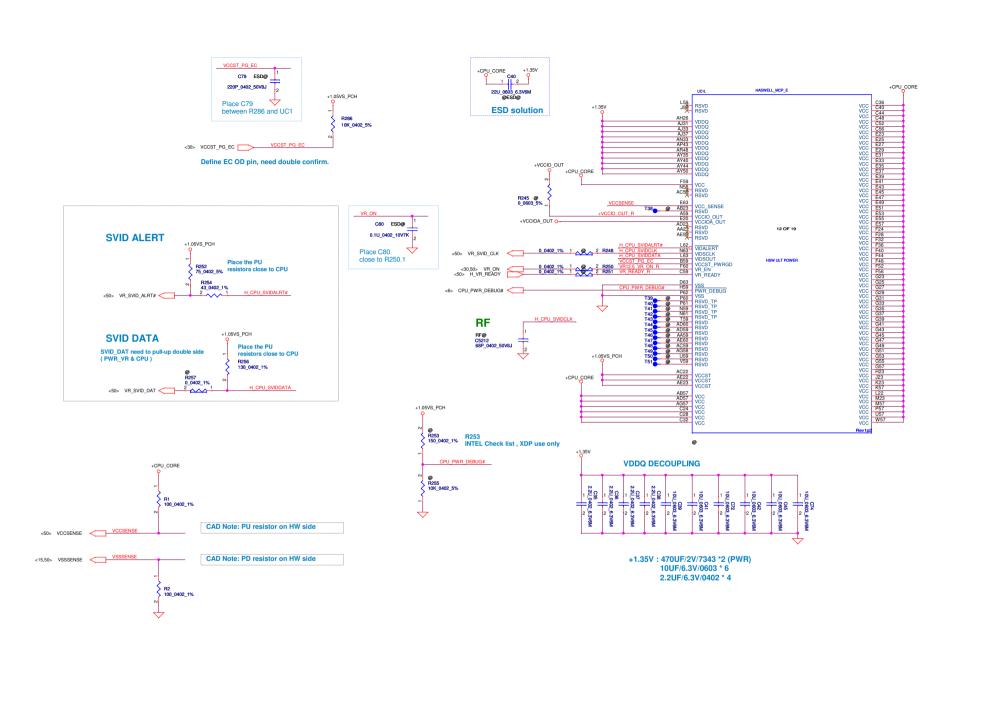
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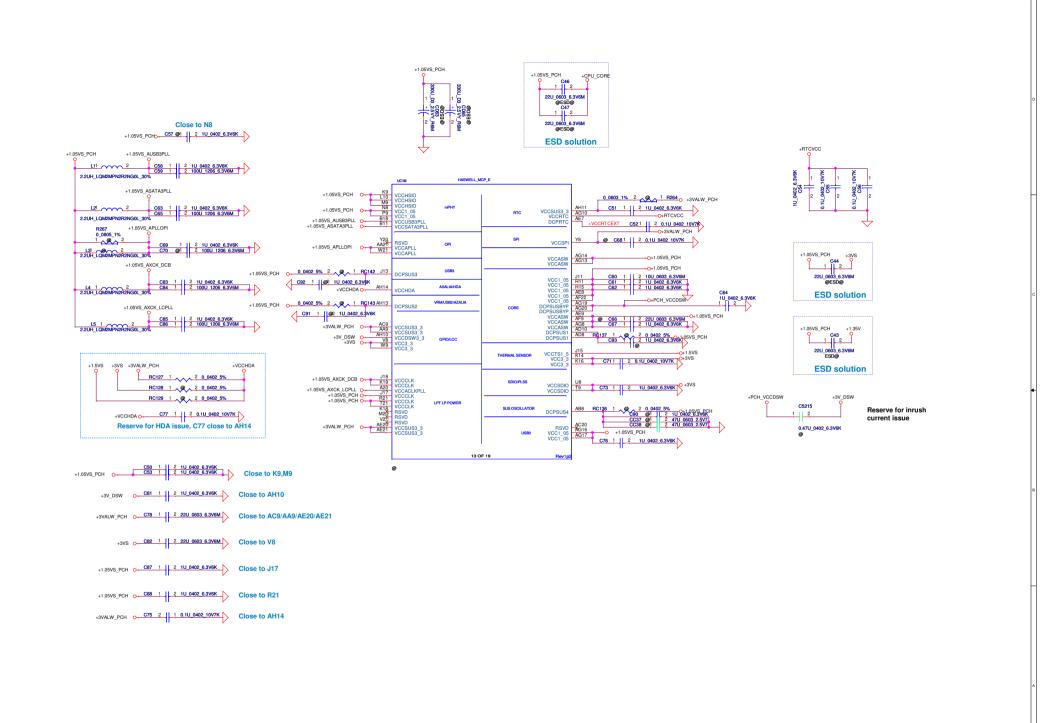




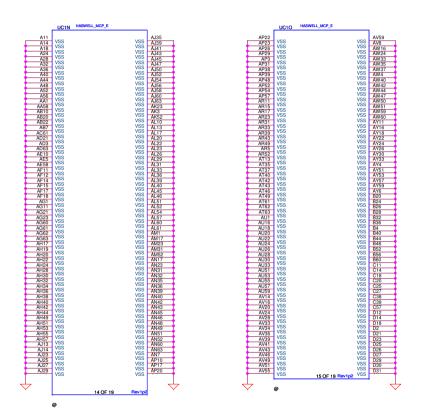
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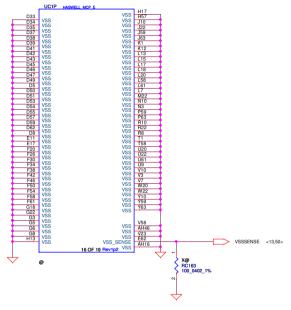


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CAD Note: RC163 SHOULD BE PLACED CLOSE TO CPU

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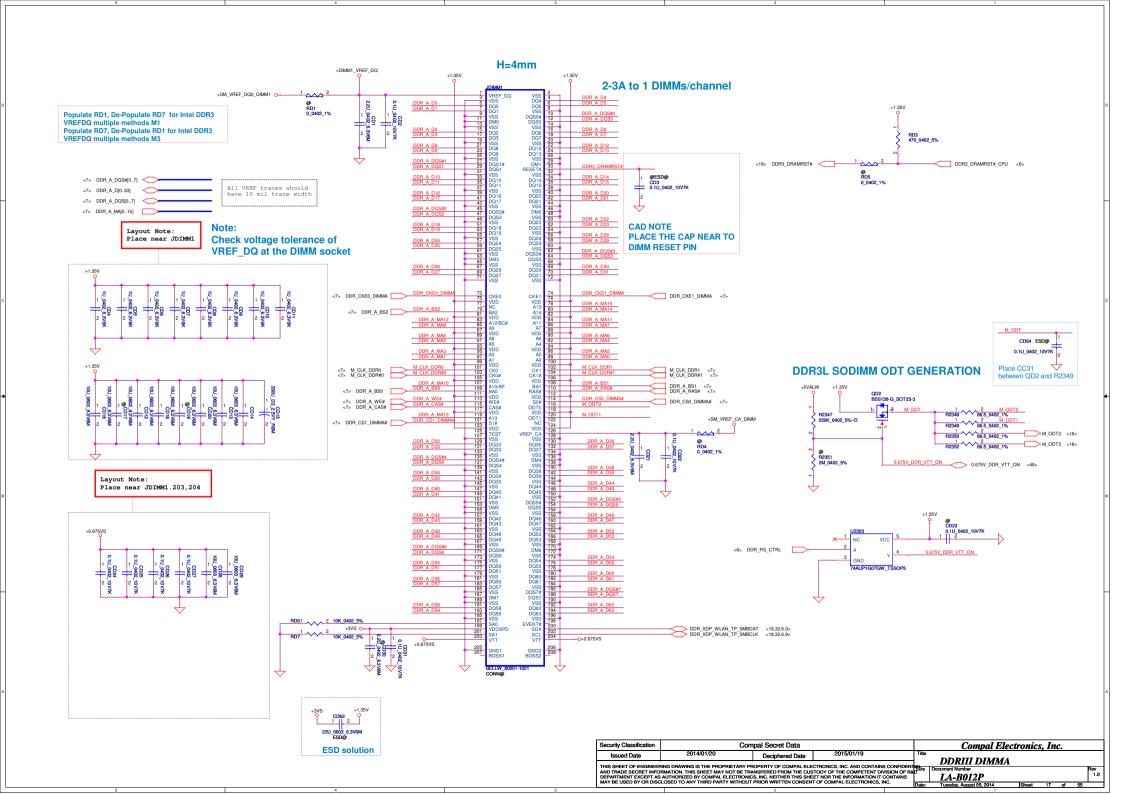
AC60 CFG0 AC62 CFG1 AC63 CFG1 AC63 CFG1 AC63 CFG1 AA63 CFG2 AA63 CFG2 AC64 CFG6 CFG AC64 CFG 65 CFG0 65 CFG1 65 CFG3 65 CFG3 65 CFG4 65 CFG5 65 CFG6 65 CFG7 65 CFG9 65 CFG1 PAD~D T146 @ PAD~D T147 @ PAD~D T151 @ PAD~D T152 @ PAD~D T153 @ RSVD_TP L60 RSVD N60 PAD~D T154 @ PAD~D T155 @ PAD~D T156 @ RSVD RSVD PROC_OPI_RCOMP AA62 U63 CFG16 CFG18 U62 U62 CFG17 CFG19 <6> CFG16 <6> CFG18 <6> CFG17 <6> CFG19 V63 CFG_RCOMP VSS N21 @T159PAD~D __ A5 RSVD PAD~D T160 @ PAD~D T162 @ @T161PAD~D @T163PAD~D @T164PAD~D @T165PAD~D 19 OF 19 2 1 CFG RCOMP RC132 49.9 0402 1% 2 TDI IREF RC133 8.2K_0402_1% PROC_OPI_RCOMP 1 2 49.9 0402 1% RC134

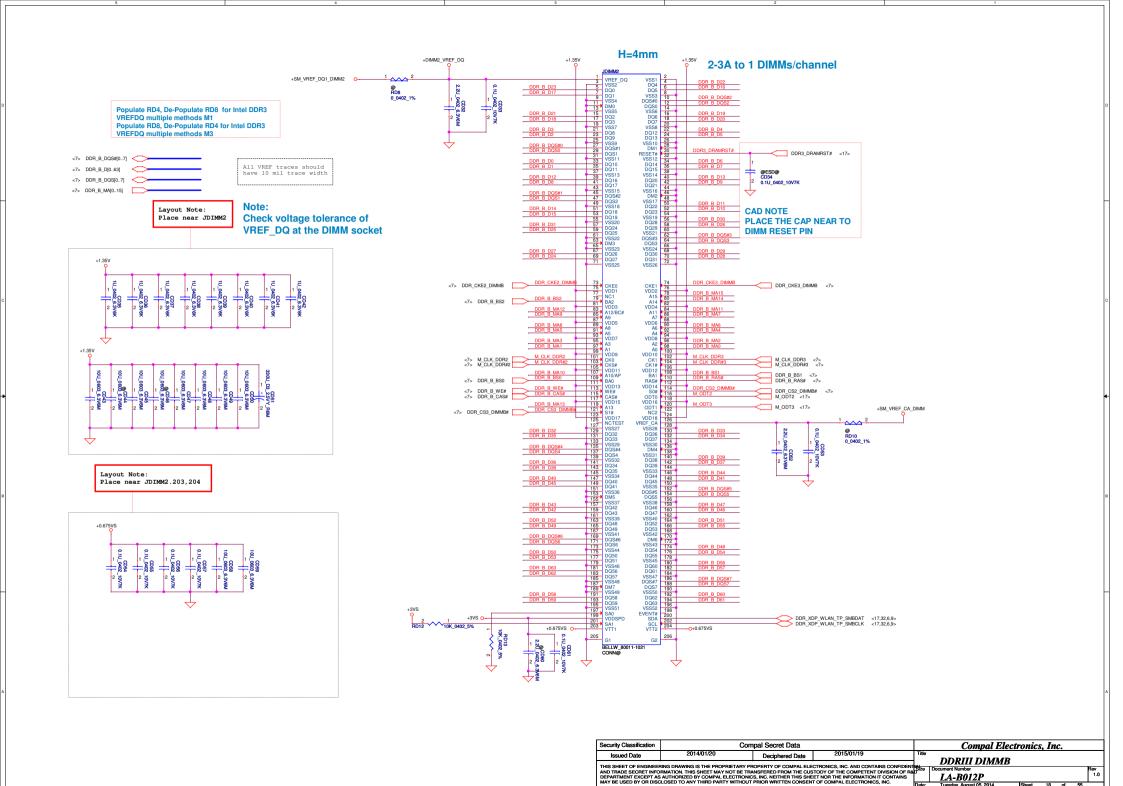
CFG STRAPS for CPU

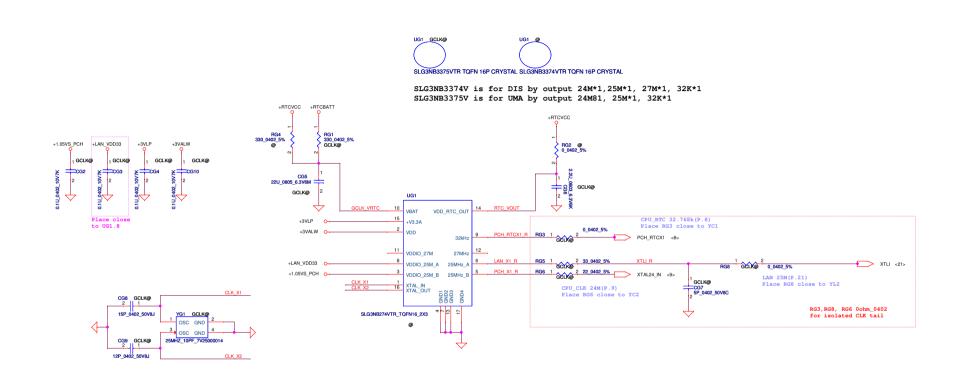


	Display Port Presence Strap
CFG4	Disabled; No Physical Display Port attached to Embedded Display Port Enabled; An external Display Port device is connected to the Embedded Display Port

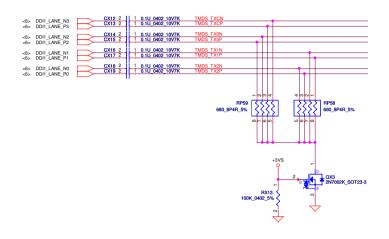
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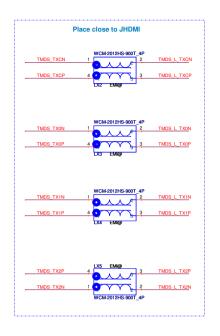


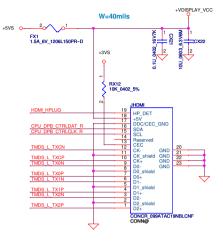




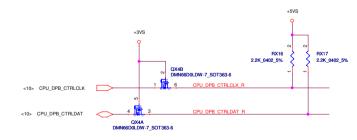
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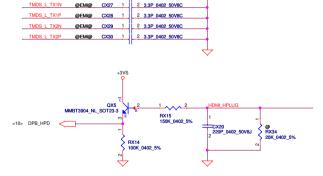






16@	ROYALTY HDMI W/LOGO
Part Number	Description
R00000002HM	HDMI W/Logo:R00000002HM



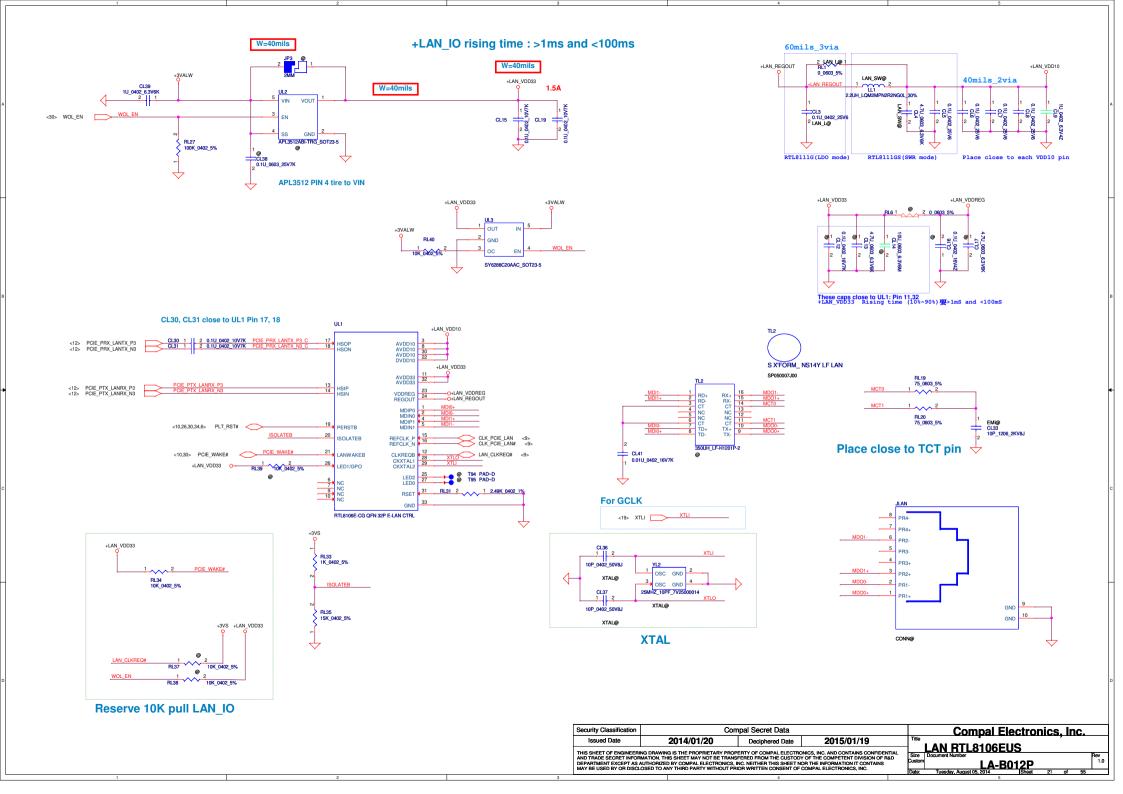


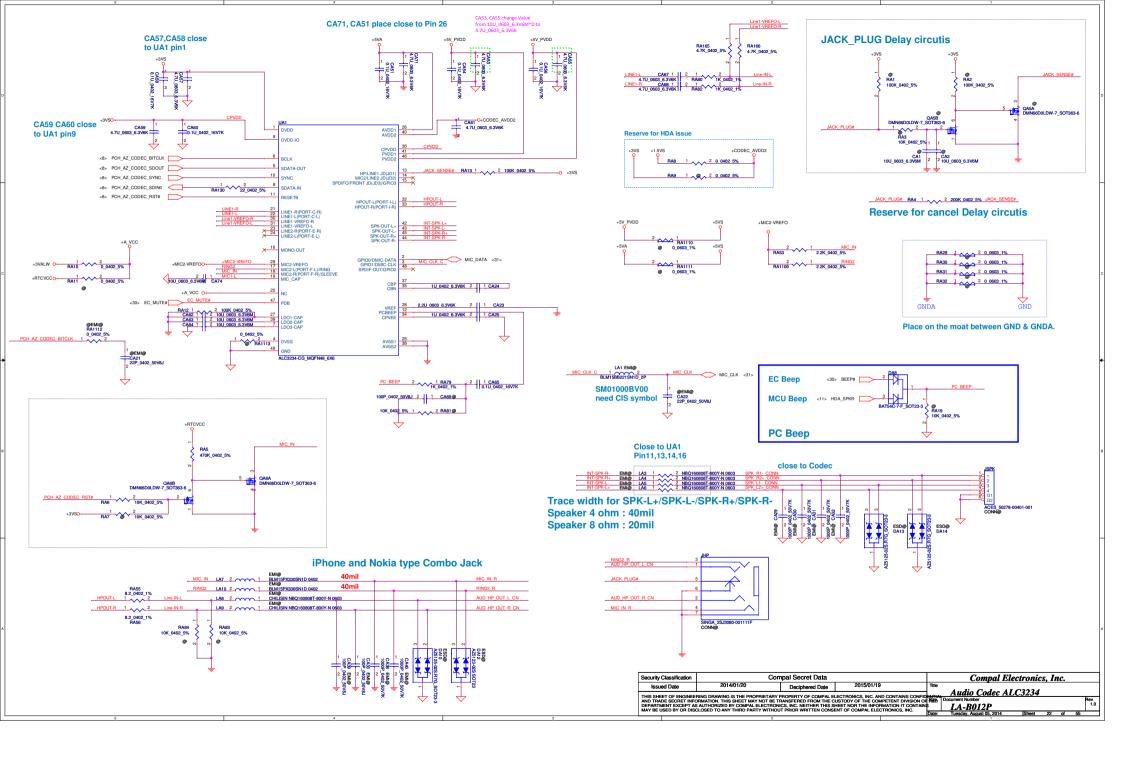
 TMDS L TXCN
 @EMI@
 CX23
 1
 2
 3.3P 0402 50V8C

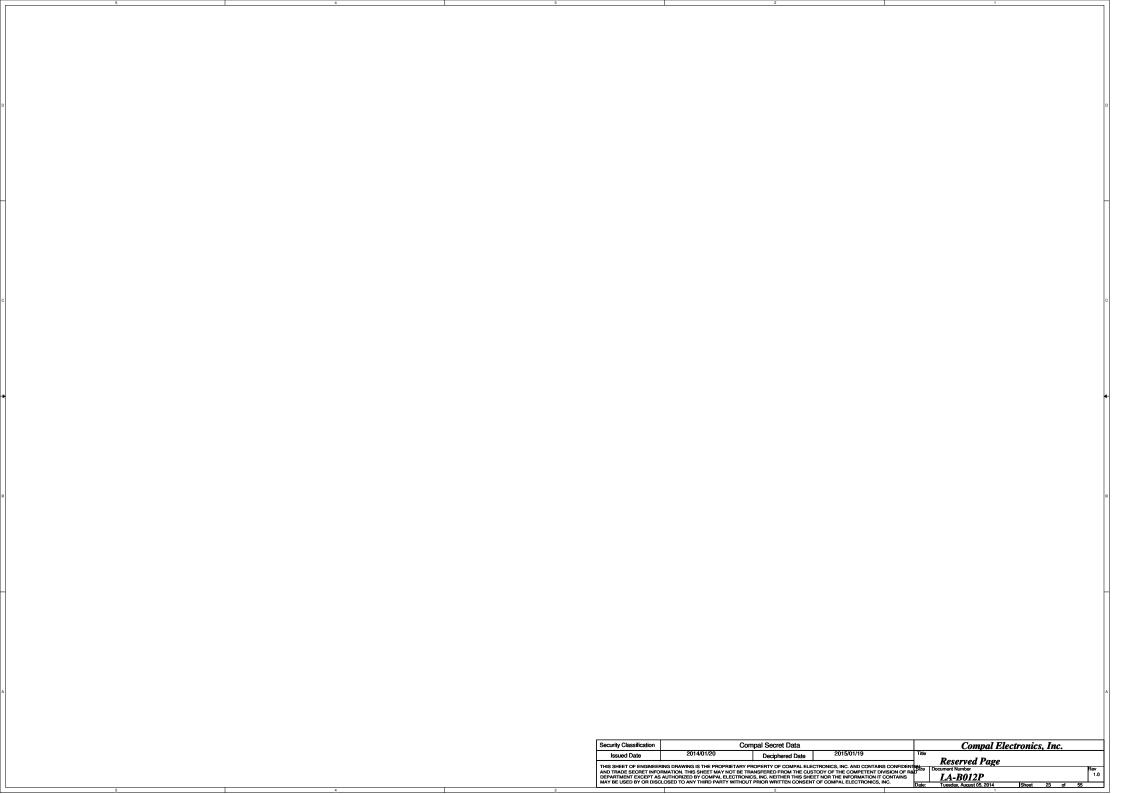
 TMDS L TXCP
 @EMI@
 CX24
 1
 2
 3.3P 0402 50V8C

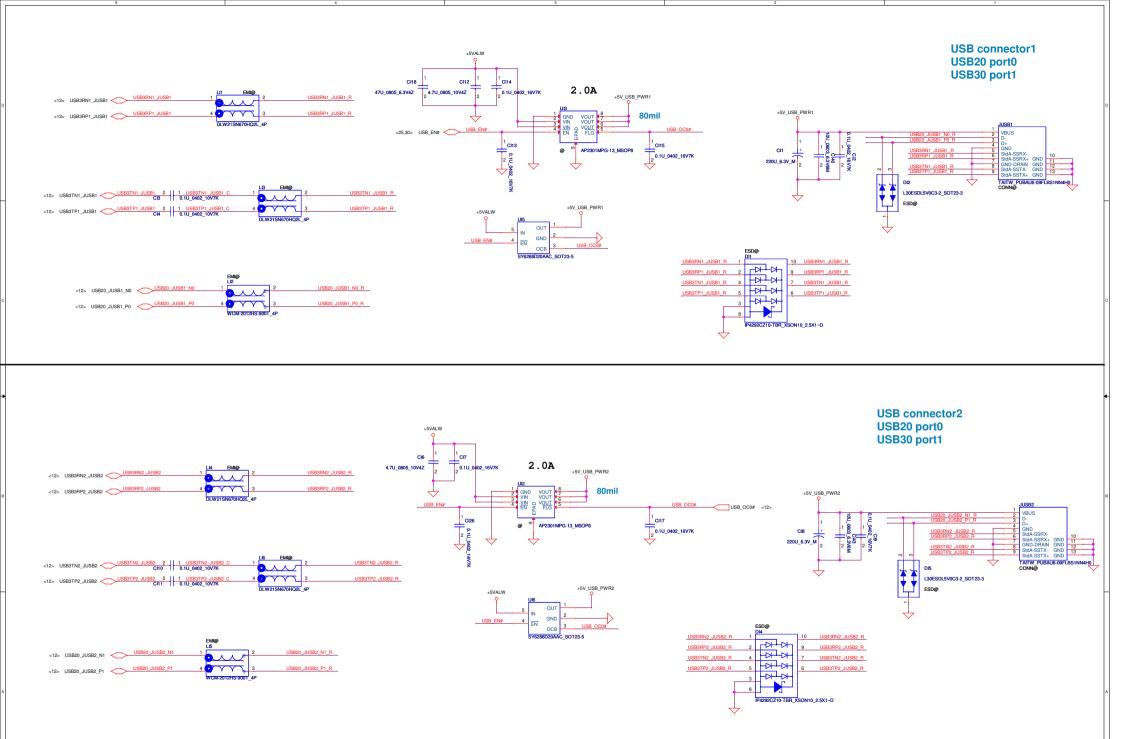
 TMDS L TXON
 @EMI@
 CX25
 1
 2
 3.3P 0402 50V8C

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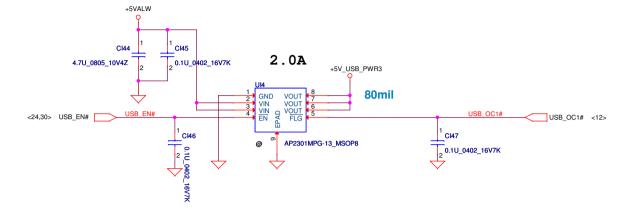


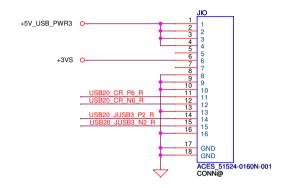


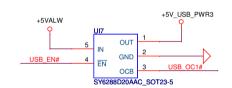


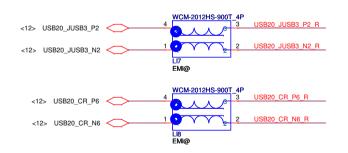


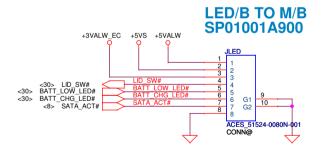




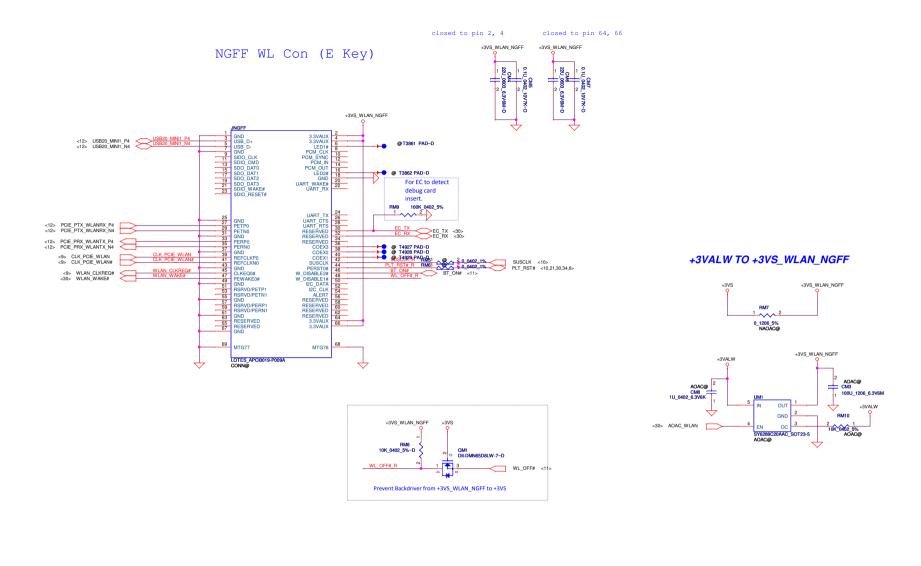




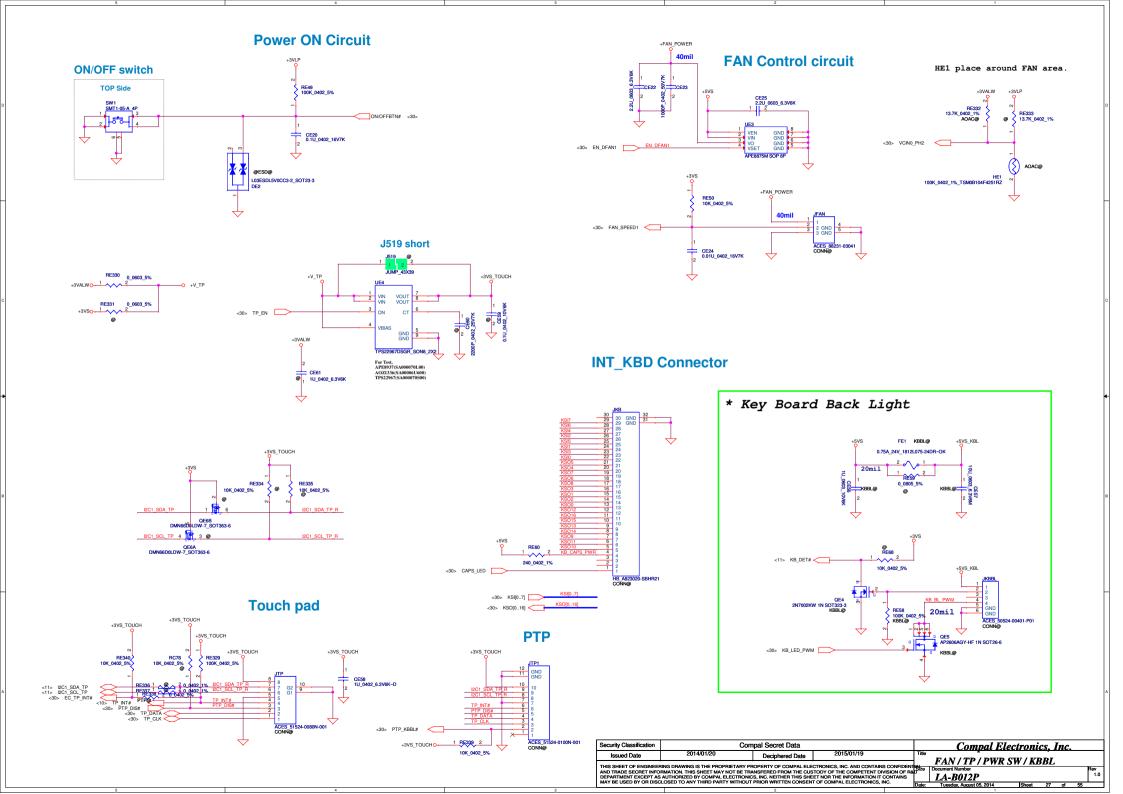




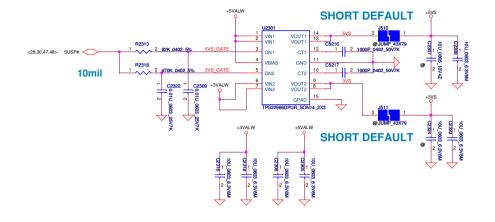
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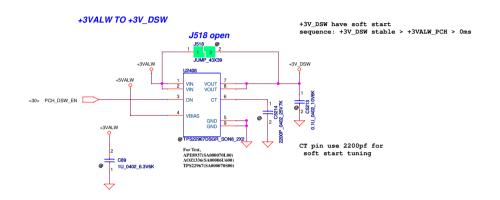


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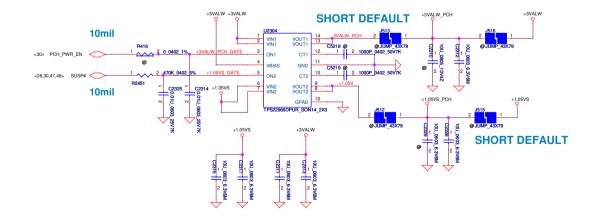


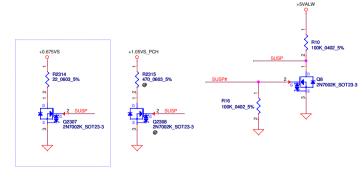
+5VS and +3VS switch





+3VALW_PCH switch

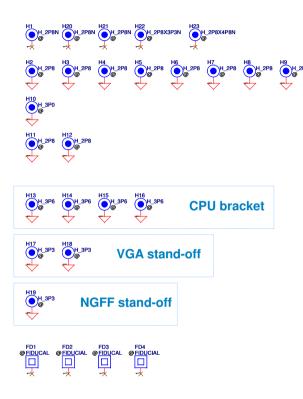




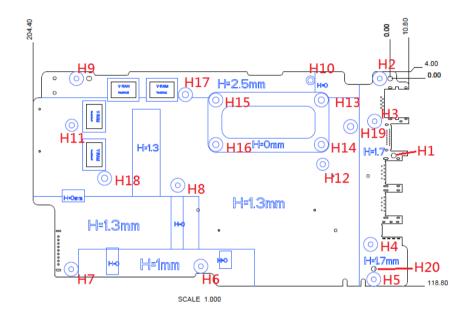
For Intel S3 Power Reduction

Security Classification		pal Secret Data			Compal Elect	ronic	s, In	c.		
Issued Date	2014/01/20	Deciphered Date	2015/01/19	Title	DC/DC Interface					
THIS SHEET OF ENGINEER	RING DRAWING IS THE PROPRIETARY PROPRIETAR	NTIAL	DC/DC Interjace Document Number				Re	ev		
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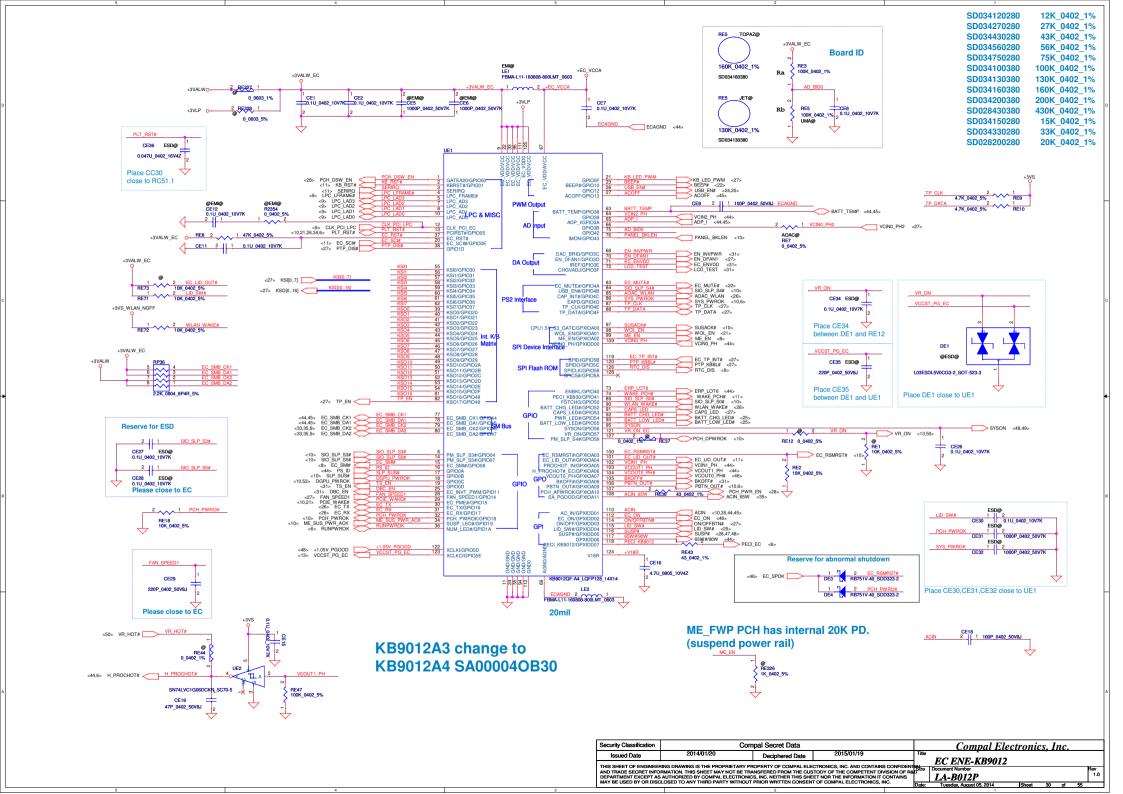
Screw Hole

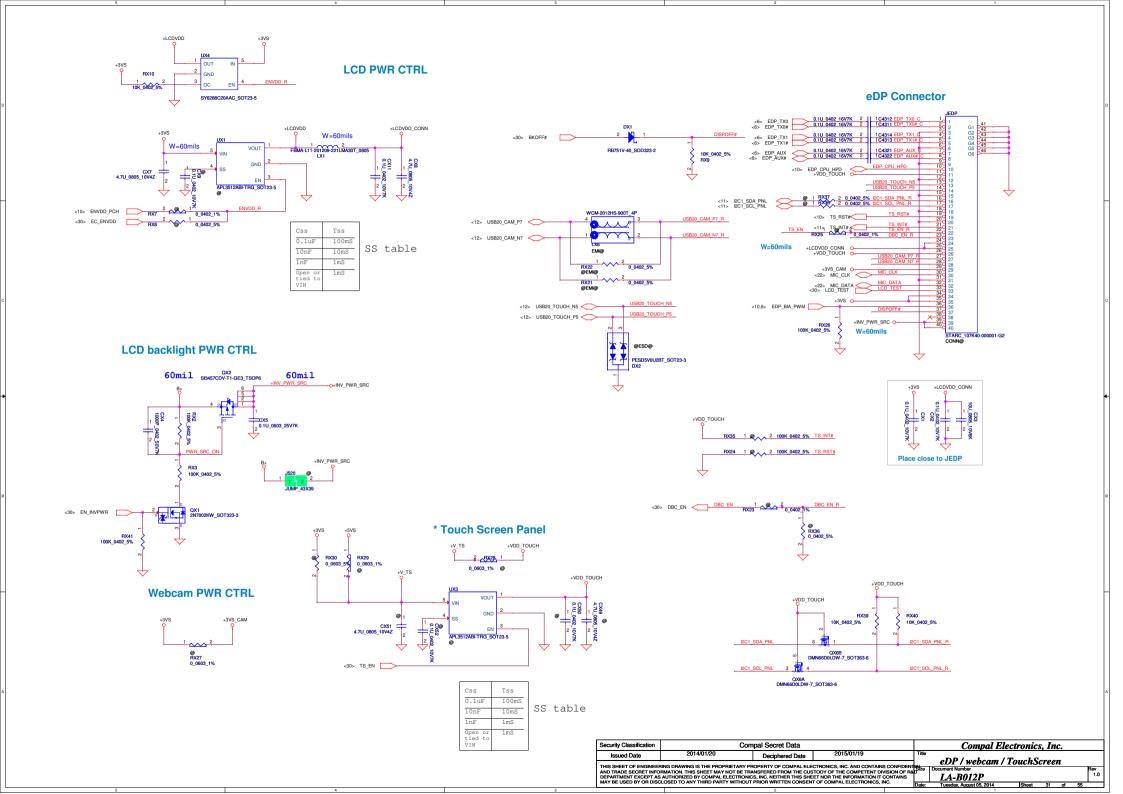




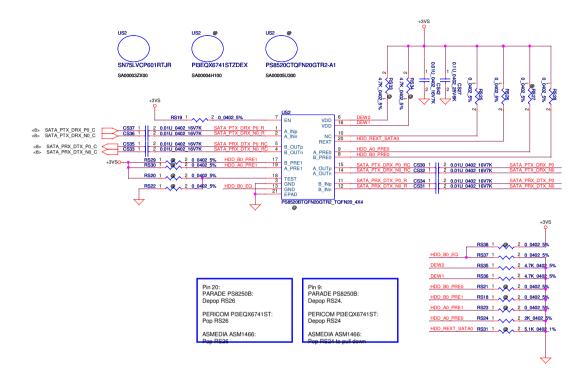


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DEPARTMENT EXCEPT AS	AUTHORIZED BY COMPAL ELECTR	ONICS, INC. NEITHER THIS SH	ECTRONICS, INC. AND CONTAINS CONFIDE ISTODY OF THE COMPETENT DIVISION OF IEET NOR THE INFORMATION IT CONTAINS NT OF COMPAL ELECTRONICS. INC.		<i>LA-B012P</i>				ľ	Rev 1.0
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SATA HDD Connector

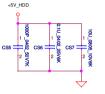


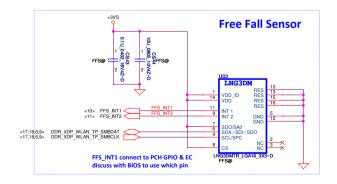


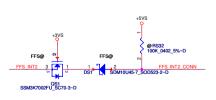
+5V HDD Source



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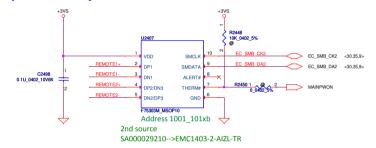




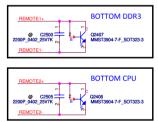


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Fintek thermal sensor placed near by TOP DDR3

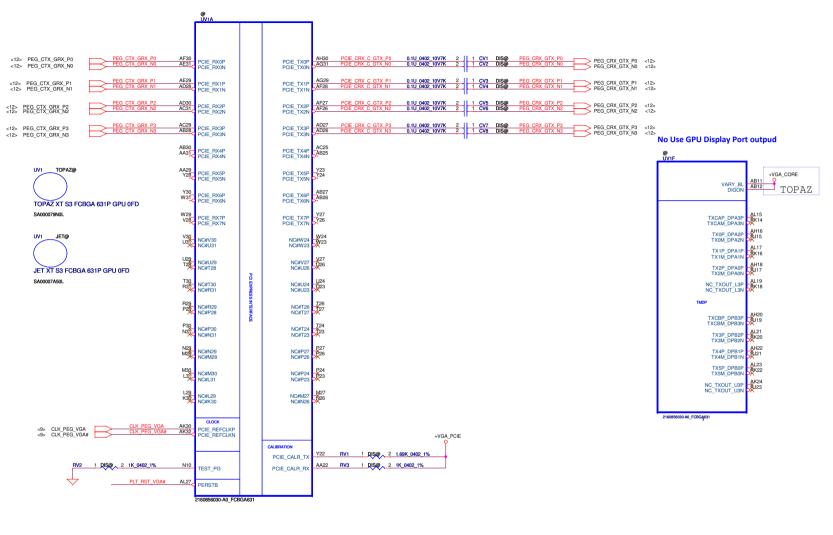


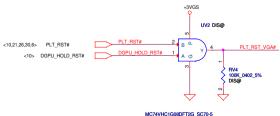




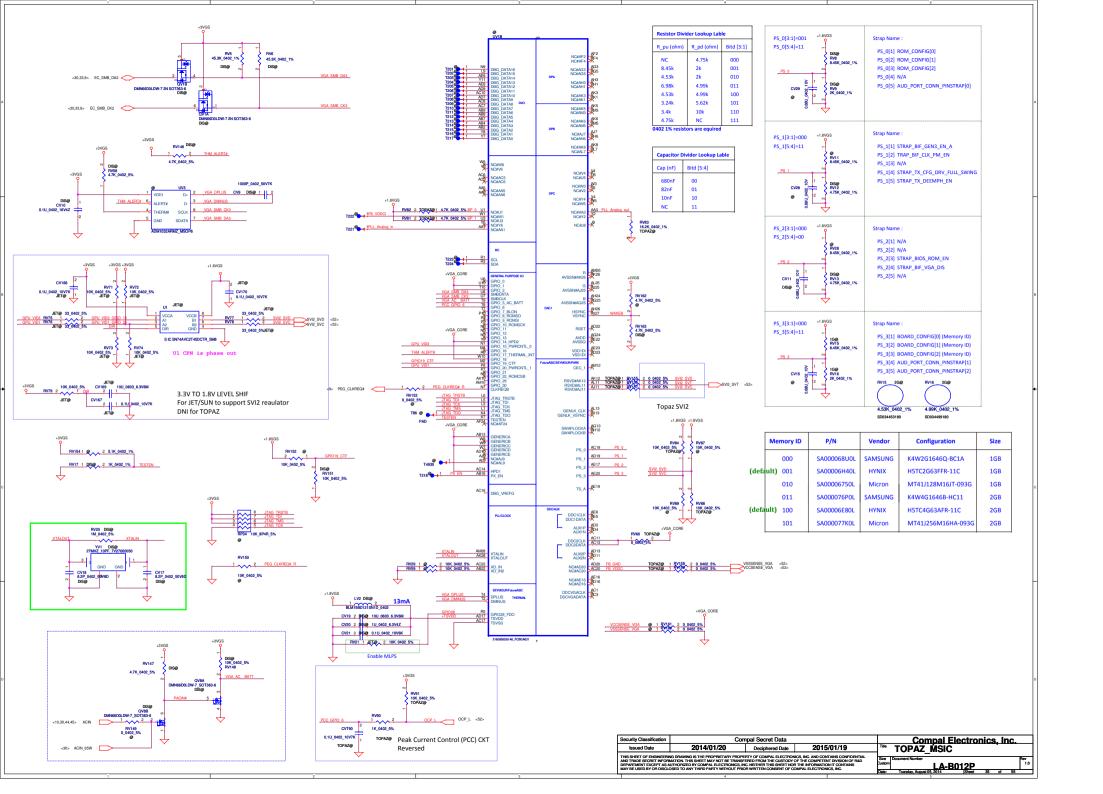
REMOTE1,2 (+/-):
Trace width/space:10/10 mil
Trace length:<8"

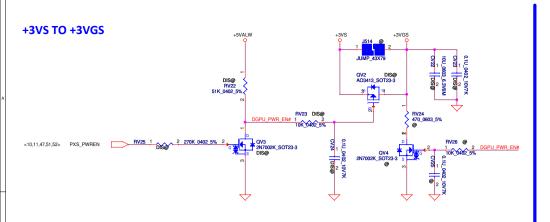
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	THIS SMEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS COMPIDENTIAL AND TRADE SECRET INFORMATION. THIS SMEET MAN OTHER TRANSPERSE FROM THE CUSTORY OF THE COMPITENT DIVISION OF RAD DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SMEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THEIR DAYS WHITCH CONSIDER OF COMPAL ELECTRONICS, INC.				Size	Thermal Sensor Document Number				_	Rev	
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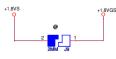


+1.35VS_VGA TO +1.35V_MEM_GFX

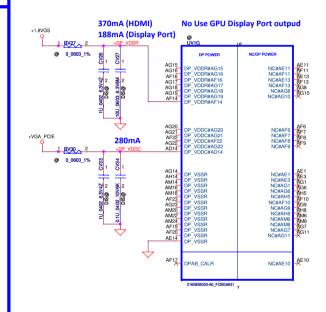


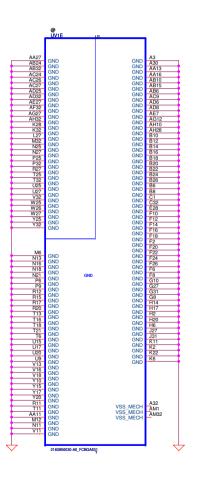
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+1.8VS TO +1.8VGS

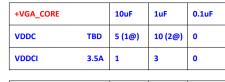


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+VGA_PCIE		10uF	1uF	0.1uF
PCIE_VDDC	2.5A	2 (1@)	5 (1@)	0
BIF_VDDC	1.4A	0	1	0
SPLL_VDDC	100mA	1	1	1

+1.35V_MEM_GFX	10uF	2.2uF	0.1uF	0.01uF
VDDR1 1.5A	3	5	5	5

+1.8VGS		10uF	1uF	0.1uF
PCIE_PVDD	100mA	1	1	1
MPLL_PVDD	130mA	1	1	1
SPLL_PVDD	75mA	1	1	1
VDDR4	(300mA)	0	0	0
VDD_CT	13mA	1	1	1
+TSVDD	13mA	1	1	1
+DP_VDDR		0	0	0
+DP_VDDC		0	0	0

10uF

25mA

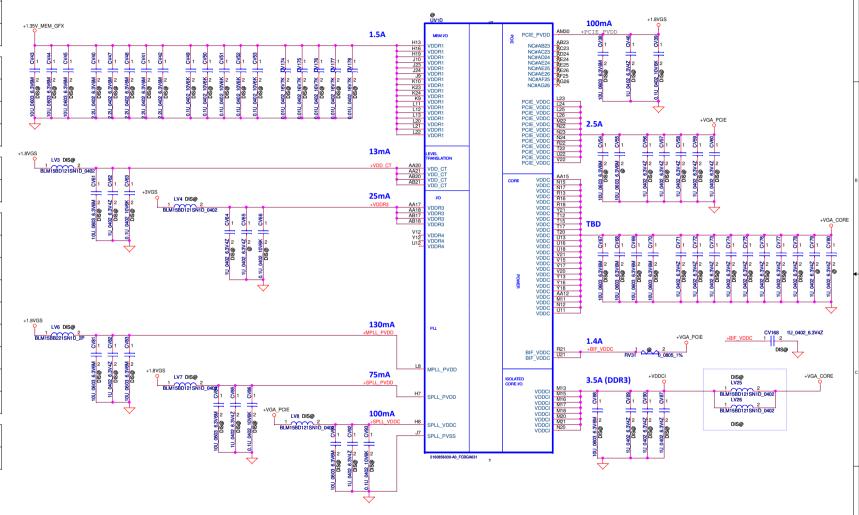
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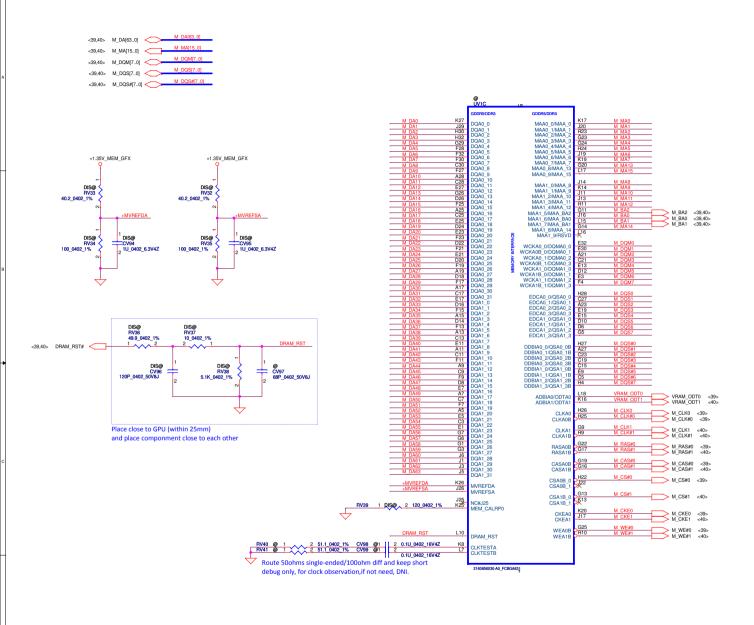
0.1uF

+3VGS

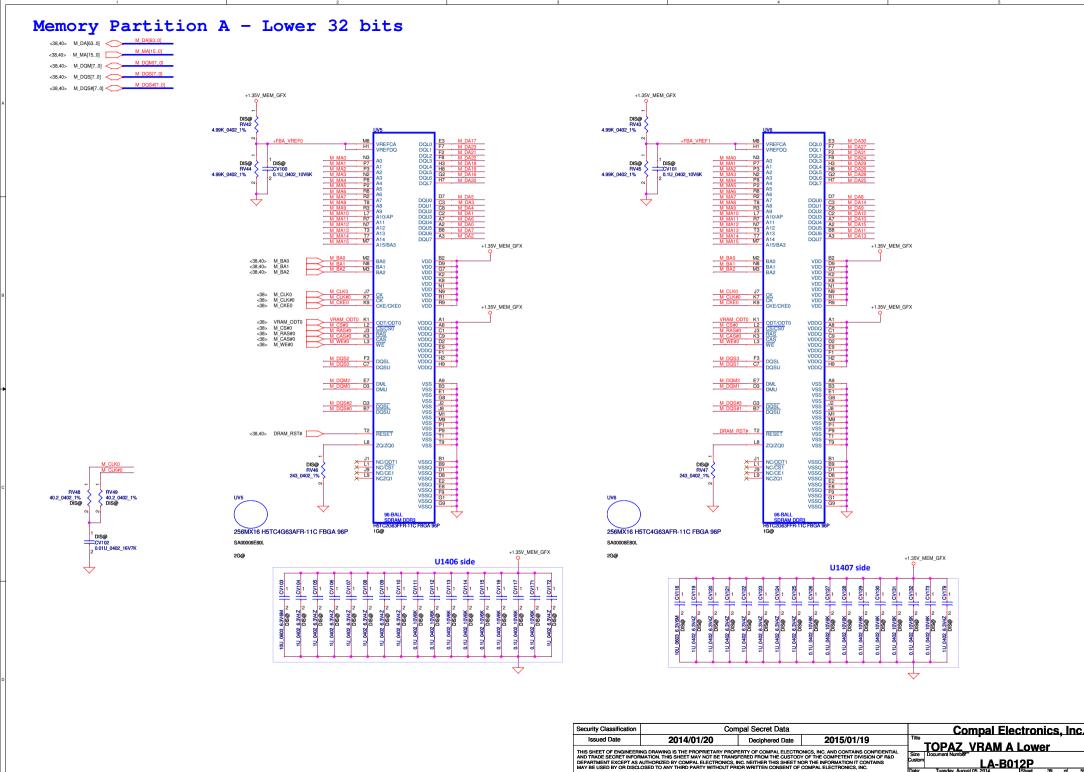
VDDR3

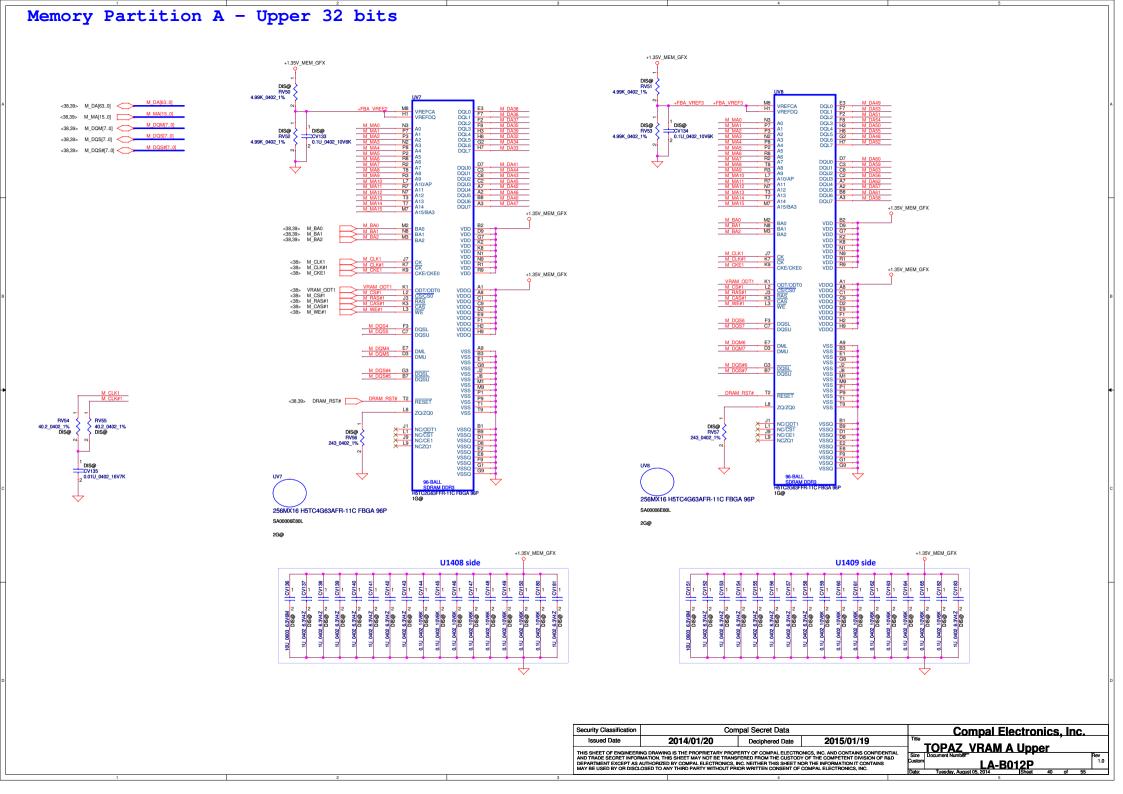


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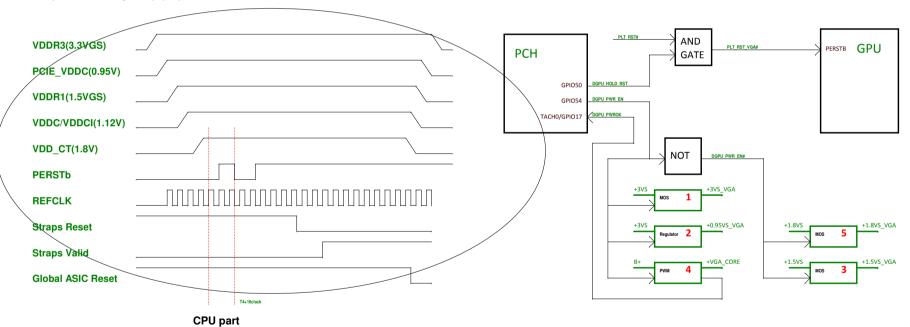
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MAY BE USE	D BY OR DISCL	OSED TO ANY THIRD PARTY WITHOUT PR	IOR WRITTEN CONSENT OF	COMPAL ELECTRONICS, INC.	2.1	LA-DUIZE	

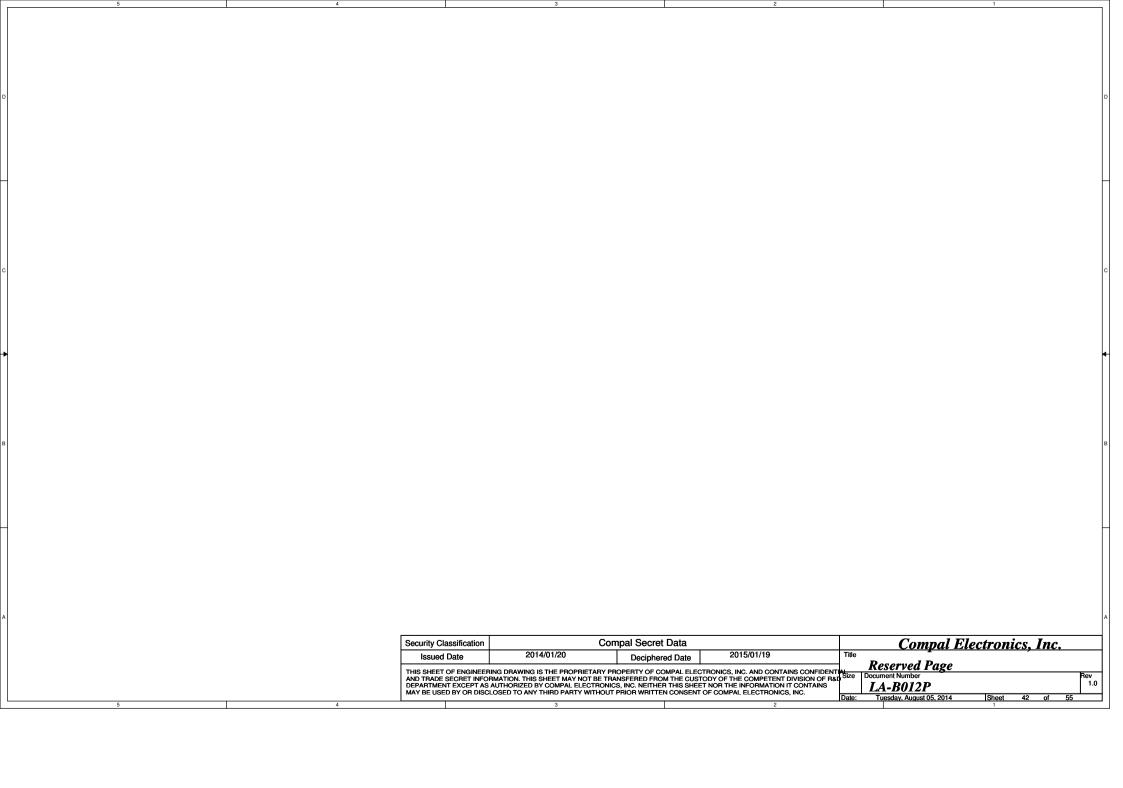


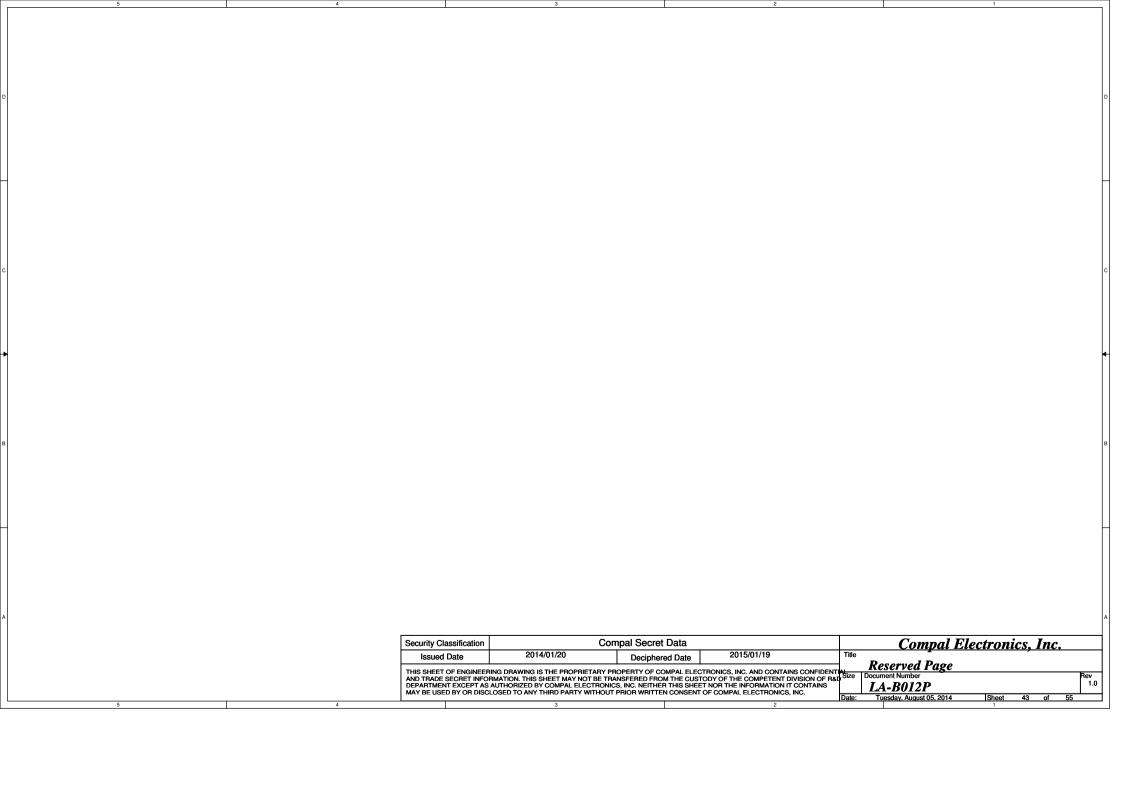


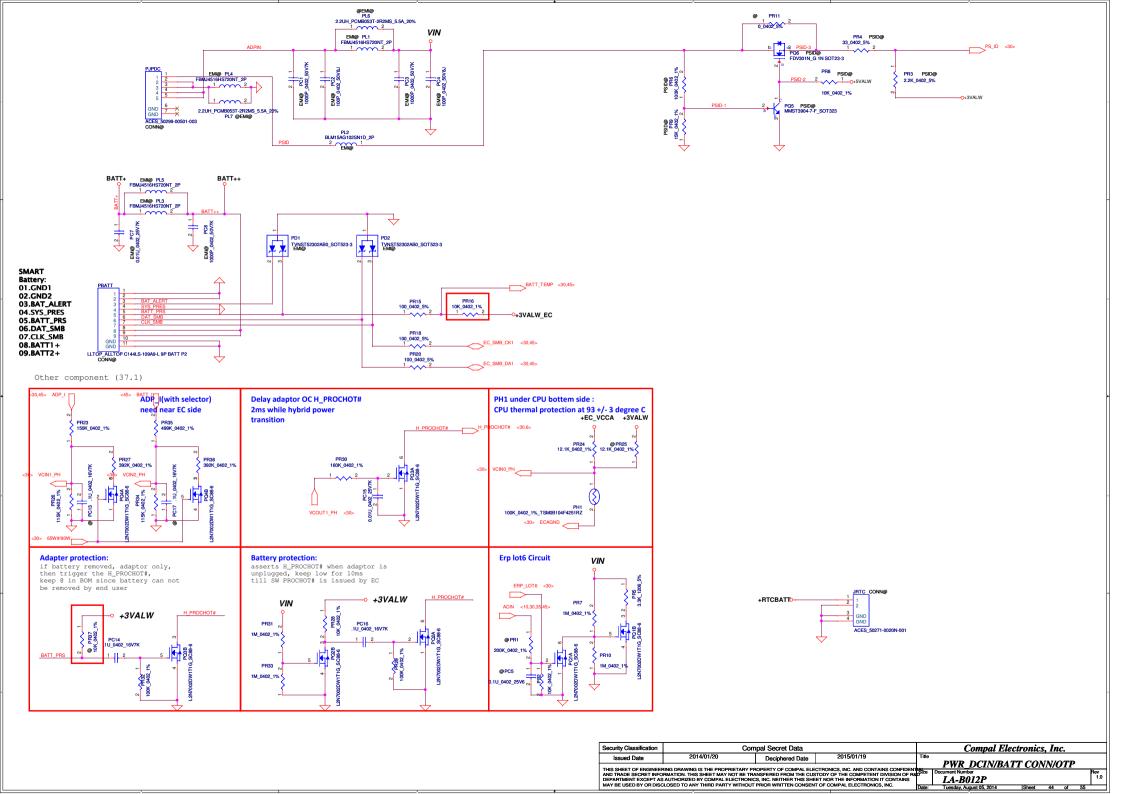
Power-Up/Down Sequence

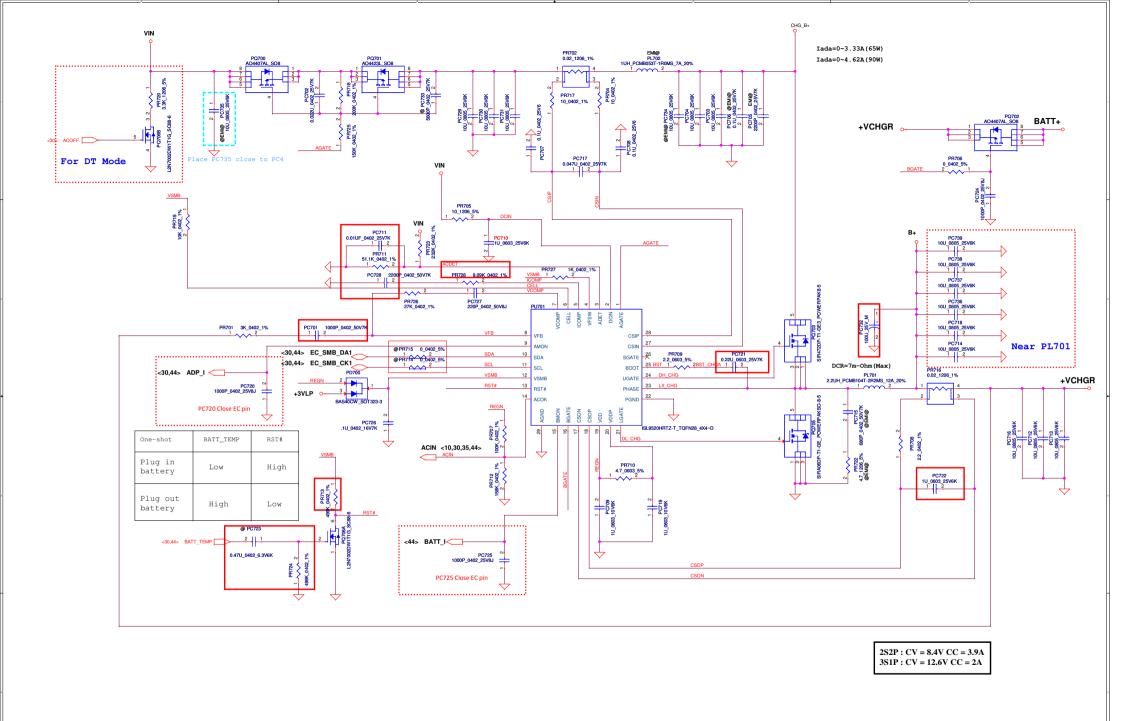
- 1. All the ASIC supplies must reach their respective nominal voltages within 20 ms of the start of the ramp-up sequence, though a shorter ramp-up duration is preferred. The maximum slew rate on all rails is 50 mW/us.
- 2. The external pull ups on the DDC/AUX signals (if applicable) should ramp up before or after both VDDC and VDD_CT have ramped up.
- 3. VDDC and VDD_CT should not ramp up simultaneously. For example, VDDC should reach 90% before VDD_CT starts to ramp up (or vice versa).
- 4. For power down, reversing the ramp-up sequence is recommended.











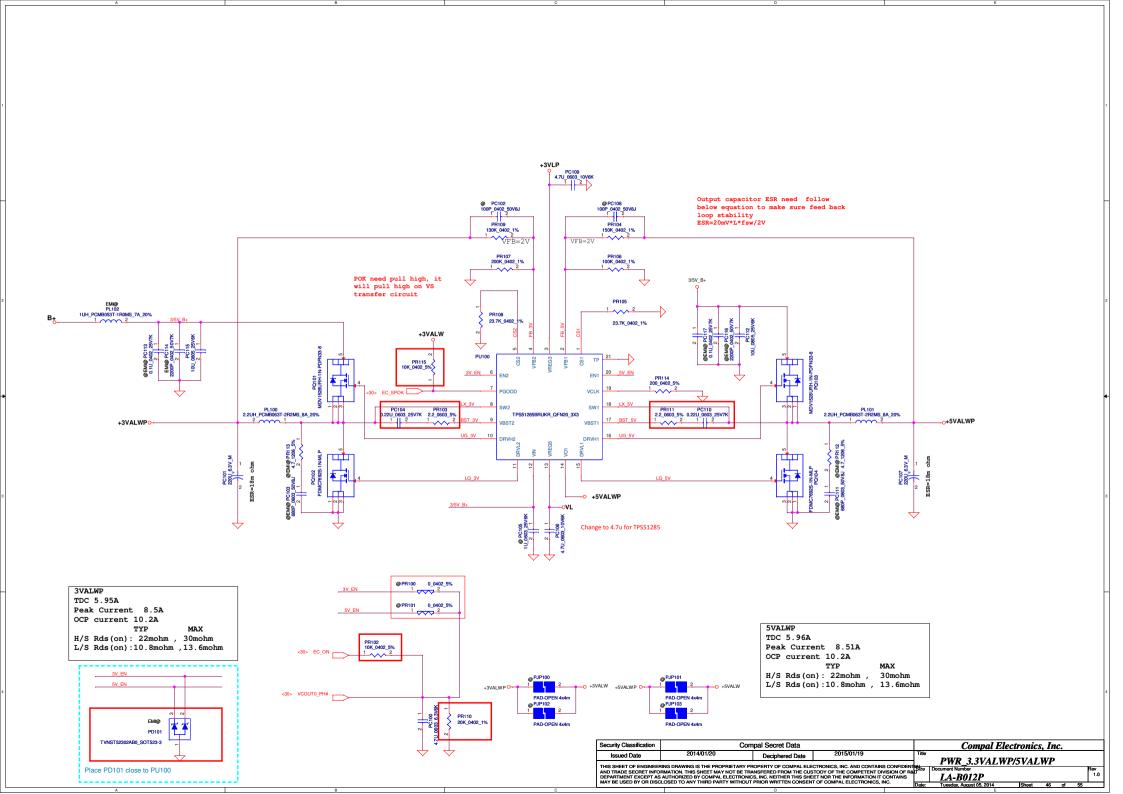
Security Classification Compal Secret Data Compal Electronics, Inc.

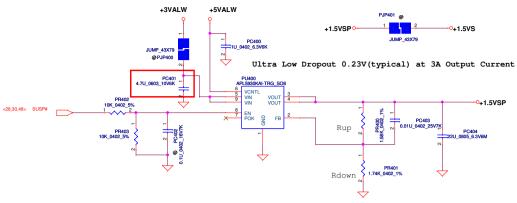
Issued Date 2014/01/20 Deciphered Date 2015/01/19 Title

PWR CHARGER

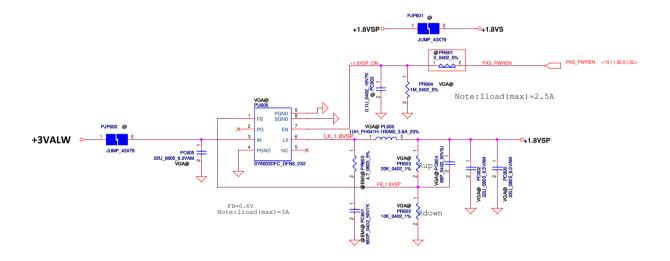
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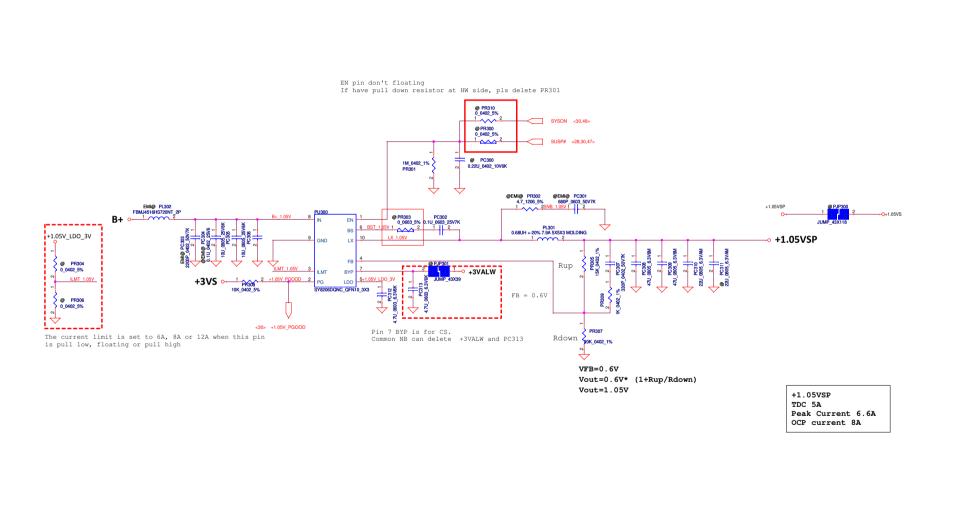




Vout=0.8V* (1+Rup/Rdown)



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Security Classification

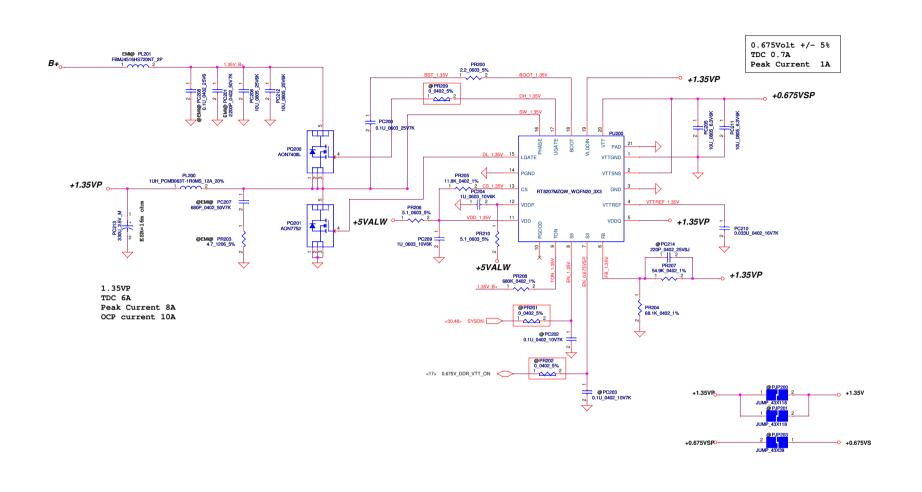
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2014/01/20

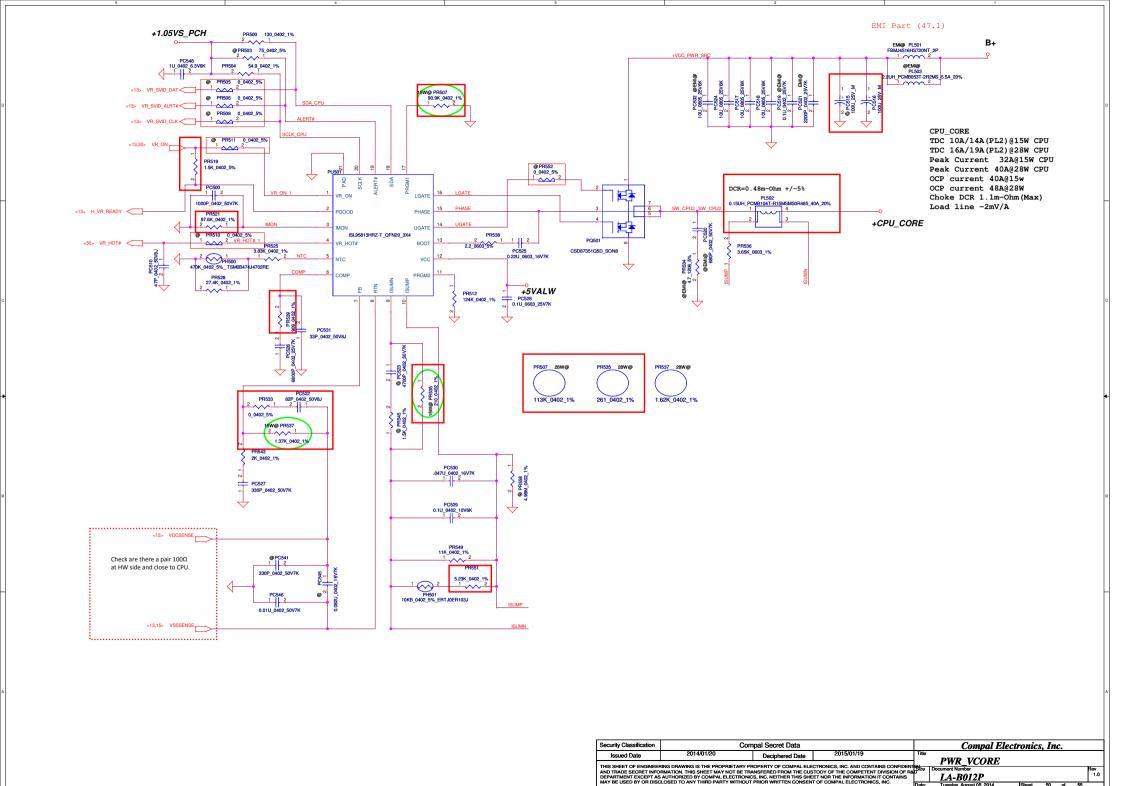
Deciphered Date

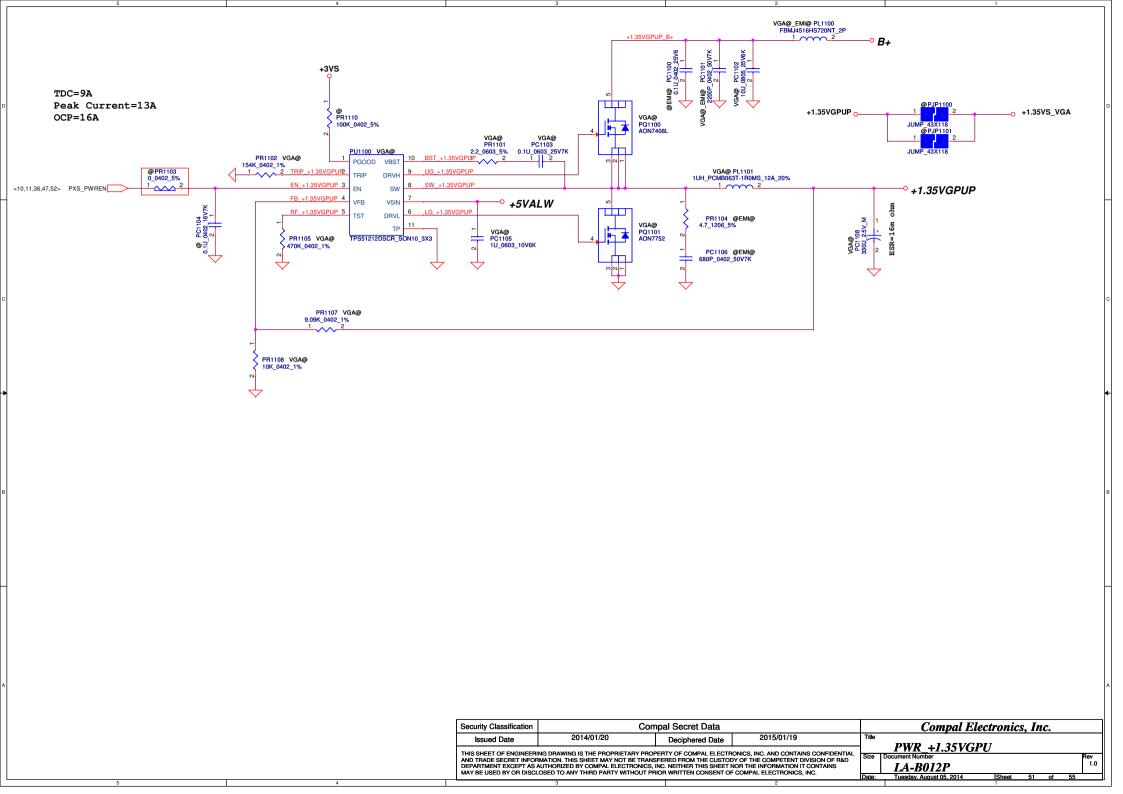
2015/01/19

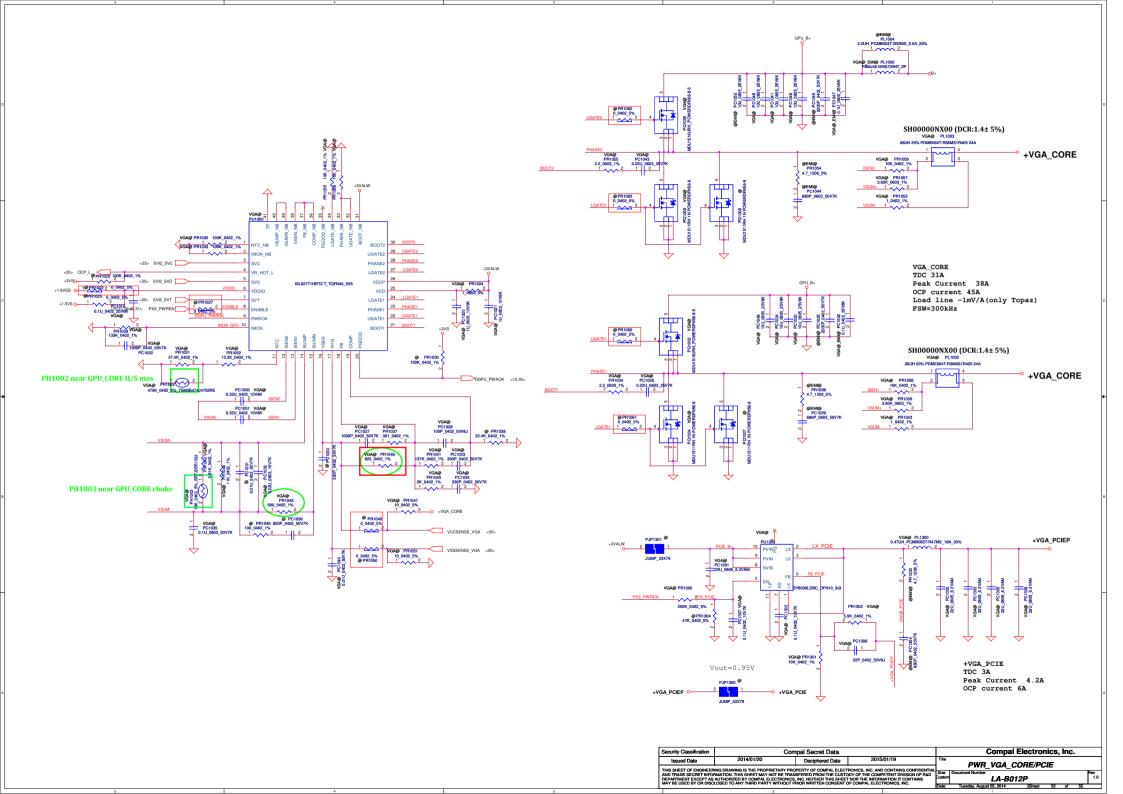
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MAY BE USED YOR DISCLOSED TO ANY THIRD PARTY WITHOUT PROBNETT OF COMPAL ELECTRONICS. NO.

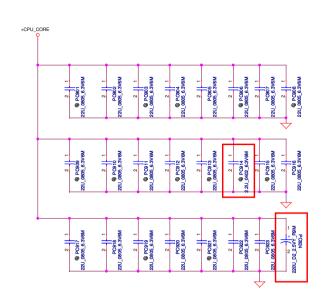


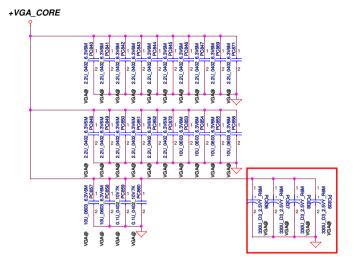
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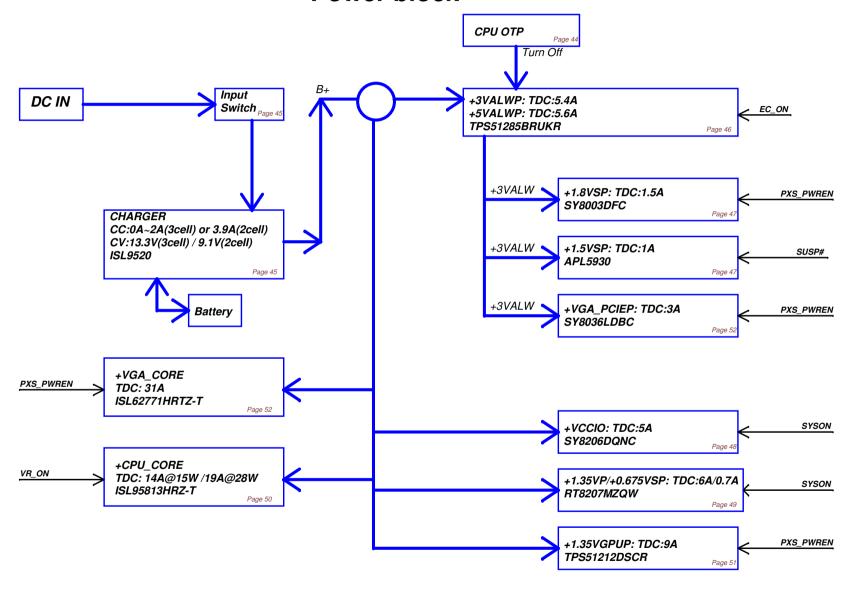






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	S AUTHORIZED BY COMPAL ELECTRONI SLOSED TO ANY THIRD PARTY WITHOU		EET NOR THE INFORMATION IT CONTAINS		<u> </u>		

Power block



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MAT BE USED BY OR DISC	LOSED TO ANY THIRD PARTY WITHOUT	Date:	Tuesday, August 05, 2014	Sheet	54	of 5	5			

Version Change List (P. I. R. List)

Page 1

Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
1	44	DCIN/BATT CONN/OTP	13/10/24	Morris	design change	change PR16 from 100K to 10K add PR37 10K	0.2
2	45	CHARGER	13/10/24	Morris	design change	change PC711 from 1000pF to 0.01uF change PR711 from 49.9K to 51.1K change PR713 from 10K to 499K change PR724 from 100K to 499K change PR724 from 0.047u to 0.22u change PC722 from 0.1u to 1u add PC732 100u	0.2
3	46	3.3VALWP/5VALWP	13/10/24	Morris	design change for solve can't root issue	change PC104 from 0.1u to 0.22u change PC110 from 0.1u to 0.22u change PR102 from 2.2K to 10K add PR110 20K	0.2
4	50	VCORE	13/10/24	Morris	adjust CPU parameter	change PR507(15W@) from 90.9K to 169K change PR519 from 1.91K to 10K change PR511 from 95.3K to 97.6K change PR539 from 8.06K to 909 change PC515,PC516 from SF000005100 to SF000004M00 change PC515,PC516 from SF00000N00 to SF0000004M00 change PL502 from SH00000NN00 to SH00000PQ00 change PR535(15W@) from 340 to 210 change PR537 from 1.27K to 1.37K change PR537 from 1.27K to 2.51K change PR535 from 2.61K to 5.23K add PC522 82PF add PR533 0-0hm	0.2
6	52	VGA_CORE/PCIE	13/10/24	Morris	design change from vendor change LL	change PR1040 from 1.24K to 825	0.2
7	53	PROCESSOR DECOUPLING	13/10/24	Morris	adjust CPU parameter	change PC924 from SGA20331E10 to SGA00009800 remove PC901, PC903, PC904, PC906, PC908, PC909, PC910, PC911, PC912, PC913, PC914, PC915, PC917, PC919, PC921	0.2
8	45	CHARGER	13/10/28	Morris	design change for plug out battery shut down issue	change PC723 from 0.01uF to 0.47uF change PR728 from 0 to 9.09K change PC728 from 4700pF to 2200pF change PC701 from 220pF to 1000pF	0.2
9	46	3.3VALWP/5VALWP	13/12/12	Morris	design change from EE request	add FR115 10K-ohm	0.3
10	50	VCORE	13/12/12	Morris	design change from Intel recommend	change PR519 from 10K to 1.5K	0.3
11	48	+VCCIO	13/12/13	Morris	design change from EE request	delete PR310 and add PR300 0-ohm	0.3
12	50	VCORE	14/01/20	Morris	adjust CPU parameter	change PR507(15W@) from 169K to 90.9K change PR507(28W@) from 205K to 113K	1.0
13	53	PROCESSOR DECOUPLING	14/02/13	Morris	design change from thermal request	change PC836 PC837 PC838 PC839 from SGA20331E10 to SGA00006A00	1.0

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DEPARTMENT EXCEPT AS	RMATION. THIS SHEET MAY NOT BE TI	RANSFERED FROM THE CUS ICS, INC. NEITHER THIS SHE	CTRONICS, INC. AND CONTAINS CONFIDEN STODY OF THE COMPETENT DIVISION OF R EET NOR THE INFORMATION IT CONTAINS	Size	Document Number LA-B012P	Rev 1.0